

AD-A152 323

NWC TP 6499

2

Thermally Stable Elastomers: Review of Silarylene-Siloxane Polymers and Polysilmethylenes

by
Robert A. Rhein
Advanced Technology Division
Ordnance Systems Department

OCTOBER 1984

NAVAL WEAPONS CENTER
CHINA LAKE, CA 93555-6001



DTIC
ELECTE
APR 11 1985
S B

DTIC FILE COPY

Approved for public release, distribution unlimited.

Naval Weapons Center

AN ACTIVITY OF THE NAVAL MATERIAL COMMAND

FOREWORD

This is a review of the literature of thermally stable elastomers, consisting of either silarylene-siloxane copolymers or polysilmethylenes, that were described in the unclassified literature during the period 1950-1982. This effort was conducted during FY 1983 and was supported by Independent Research funding under Work Order No. 132890.

This report was reviewed for technical accuracy by Dr. J. C. Baldwin.

Approved by
C. L. SCHANIEL, *Head*
Ordnance Systems Department
19 October 1984

Under authority of
K. A. DICKERSON
Capt. USN
Commander

Released for publication by
B. W. HAYS
Technical Director

NWC Technical Publication 6499

Published by Technical Information Department
Collation Cover, 20 leaves
First printing 345 copies

UNCLASSIFIED

SECURITY CLASSIFICATION OF THIS PAGE (When Data Entered)

| REPORT DOCUMENTATION PAGE | | READ INSTRUCTIONS BEFORE COMPLETING FORM |
|---|-----------------------|---|
| 1. REPORT NUMBER NWC TP 6499 | 2. GOVT ACCESSION NO. | 3. RECIPIENT'S CATALOG NUMBER |
| 4. TITLE (and Subtitle) THERMALLY STABLE ELASTOMERS: REVIEW OF SILARYLENE-SILOXANE POLYMERS AND POLYSILMETHYLENES (U) | | 5. TYPE OF REPORT & PERIOD COVERED Review |
| | | 6. PERFORMING ORG. REPORT NUMBER |
| 7. AUTHOR(s) Robert A. Rhein | | 8. CONTRACT OR GRANT NUMBER(s) |
| 9. PERFORMING ORGANIZATION NAME AND ADDRESS Naval Weapons Center China Lake, CA 93555-6001 | | 10. PROGRAM ELEMENT, PROJECT, TASK AREA & WORK UNIT NUMBERS Work Order No. 132890 |
| 11. CONTROLLING OFFICE NAME AND ADDRESS Naval Weapons Center China Lake, CA 93555-6001 | | 12. REPORT DATE October 1984 |
| | | 13. NUMBER OF PAGES 38 |
| 14. MONITORING AGENCY NAME & ADDRESS (if different from Controlling Office) | | 18. SECURITY CLASS. (of this report) UNCLASSIFIED |
| | | 18a. DECLASSIFICATION/DOWNGRADING SCHEDULE |
| 16. DISTRIBUTION STATEMENT (of this Report) Approved for public release, distribution unlimited. | | |
| 17. DISTRIBUTION STATEMENT (of the abstract entered in Block 20, if different from Report) | | |
| 18. SUPPLEMENTARY NOTES | | |
| 19. KEY WORDS (Continue on reverse side if necessary and identify by block number) Carbosilane, Silmethylene, Elastomers, Siloxane, Polymers, Silphenylene, Silicon, Thermal stability. | | |
| 20. ABSTRACT (Continue on reverse side if necessary and identify by block number) (see back of form) | | |

DD FORM 1 JAN 73 1473

EDITION OF 1 NOV 65 IS OBSOLETE
S/N 0102-LF-014-6601

UNCLASSIFIED

SECURITY CLASSIFICATION OF THIS PAGE (When Data Entered)

UNCLASSIFIED

SECURITY CLASSIFICATION OF THIS PAGE (When Data Entered)

(U) *Thermally Stable Elastomers: Review of Silarylene-Siloxane Polymers and Polysilmethylenes* (U), by Robert A. Rhein. China Lake, Calif., Naval Weapons Center, October 1984. 38 pp. (NWC TP 6499, publication UNCLASSIFIED.)

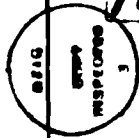
(U) This technical report is a review of the literature that pertains to two types of thermally stable elastomers: silarylene-siloxane polymers and polysilmethylenes.

(U) The silarylene-siloxane copolymers were generally prepared from the reaction of a bis(hydroxydialkylsilyl)arylene with a dialkylsilane containing two active groups, such as dichloro or bis(dimethylamino). These copolymers are thermally stable, decomposing at temperatures 50-100°C higher than that of the silicone polymers.

(U) The preparation and properties of the polydialkylsilmethylenes are discussed, with emphasis placed on polydimethylsilmethylene. These polymers are typically prepared from the ring-opening polymerization of 1,3-disilabutadienes; the preparation and physical properties of the polymers and the monomers are presented. *→cont keywords include: see 1473*

DTIC
ELECTE
S APR 11 1985 D
B

| | |
|--------------------|-------------------------------------|
| Accession For | |
| DTIC GRA&I | <input checked="" type="checkbox"/> |
| DTIC TAB | <input type="checkbox"/> |
| Unannounced | <input type="checkbox"/> |
| Justification | |
| Distribution/ | |
| Availability Codes | |
| Avail and/or | |
| Special | |
| A-1 | |



S N 0102- LF-014-6601

UNCLASSIFIED

SECURITY CLASSIFICATION OF THIS PAGE (When Data Entered)

CONTENTS

| | |
|--|----|
| Introduction | 3 |
| Bis(Hydroxydialkylsilyl)arylenes | 4 |
| Phenyl Derivatives | 4 |
| Xylyl Derivatives | 8 |
| Toluene Derivatives | 9 |
| <i>p</i> -Diphenyl Derivatives | 9 |
| <i>p</i> -Diphenyl Ether Derivatives | 9 |
| Naphthalene and Anthracene Derivatives | 10 |
| Durylene Derivatives | 10 |
| Other Derivatives | 11 |
| Poly(arylene-siloxanes) | 11 |
| <i>p</i> -Bis(silylbenzene) Derivatives | 11 |
| <i>m</i> -Phenyl Derivatives | 15 |
| <i>p</i> -Diphenyl Ether Derivatives | 16 |
| <i>m</i> -Xylyl Derivatives | 17 |
| Bis(<i>p</i> -Dimethylhydroxysilylphenyl)Dimethylsilane | 18 |
| Derivatives | 18 |
| Polysilphenylenes | 18 |
| Disilacyclobutanes | 18 |
| Grignard Preparations | 18 |
| Thermolysis Methods | 19 |
| Photolysis Methods | 20 |
| Alkali Metal Methods | 20 |
| Polysilmethylenes | 20 |
| Catalyzed Ring-Opening Polymerization | 20 |
| Thermal Ring-Opening Polymerization | 21 |
| Metal Coupling Reactions | 22 |
| Physical Properties of Polysilmethylenes | 23 |
| Conclusions | 24 |
| References | 25 |

ACKNOWLEDGMENT

The author wishes to express his appreciation to James C. Baldwin for identifying the need of this compilation, and for advice and consultation during this effort.

INTRODUCTION

This report is a review of the literature pertaining to two types of thermally stable elastomers: (1) alternating copolymers of siloxane units and silylarylene bulky groups and (2) polysilmethylenes. This effort is an expansion and continuation of NWC TP 6372.¹ Although a number of types of thermally stable elastomers were described in that review, two promising areas for further investigation appeared to be in the areas of copolymers of siloxane and bulky groups, such as silylarylene, and in the investigation of polysilmethylenes. The need for cost-effective preparation of the precursors required for making these elastomers was indicated in that review.

This report describes the preparation of these two classes of elastomers. The first type of elastomer considered here, silylarylene-siloxane polymers, is prepared by condensation polymerization of a siloxane (or di- or trisiloxane), such as dichlorodimethylsilane or bis(dimethylamino)dimethylsilane, with a bis-silanol, such as *p*-bis(hydroxydimethylsilyl)benzene. In the next section of this report the preparation and physical properties of the known types of bis-silanols are described. Most of these were made by Grignard methods, but there are a few examples of other methods of preparation that could conceivably be used in large-scale production. The various types of alternating copolymers of bis-silanols with siloxanes are described in the third section.

The other class of thermally stable elastomers described in this report is the polysilmethylenes. The polysilmethylene most frequently described in the literature, polydimethylsilmethylene, was generally prepared by the ring-opening polymerization of 1,1,3,3-tetramethyl-1,3-disilacyclobutane. Other types of polysilmethylenes have been described: these were prepared by substituting another group for methyl. The fourth section of this report describes the literature methods for preparation of 1,1,3,3-tetramethyl-1,3-disilacyclobutane and other 1,3-disilacyclobutane derivatives. The fifth section describes the literature methods for the polymerization of the cyclic monomers to the polysilmethylenes and describes the physical properties of these polymers.

BIS(HYDROXYDIALKYLSILYL)ARYLENES

PHENYL DERIVATIVES

p-Phenyl Derivatives

The type of bis(hydroxydialkylsilyl)arylenes most frequently described in the literature are those in which the arylene group is *p*-phenyl. Most of the examples of the preparation of *p*-bis(hydroxysilyl)benzene compounds were those that use the Grignard reaction of *p*-dibromobenzene, magnesium, and a silane to form a bis(silyl)benzene, followed by hydrolysis to make the corresponding bis-silanol. Other methods were used to produce *p*-bis(silyl)benzene compounds, and these are also described here.

p-Bis(dimethylhydrogensilyl)benzene was prepared from the reaction of dimethylchlorosilane, magnesium, and *p*-dibromobenzene in tetrahydrofuran (THF)²⁻⁵ or in ether.^{2,6} Another method of preparation of bis(dimethylhydrogensilyl)benzene was the reaction of *p*-dichlorobenzene with dimethylchlorosilane in the presence of dispersed sodium in octane/ether in the presence of ethyl acetate.⁷ *p*-Bis(dimethylhydrogensilyl)benzene is a liquid with a boiling point (bp) of 60-61°C/1.5mm⁶ and 112-113°C/29mm; $n_D^{20}=1.5007$, and $d_{25}^{25}=0.8832$.^{2,3}

The Grignard preparation of *p*-bis(hydrogenmethylphenylsilyl)benzene by the reaction of *p*-dibromobenzene with methylphenylchlorosilane and magnesium in THF was described.^{3,8} the physical properties of the liquid were bp=60-61°C/1.5mm⁶ and 112-113°C/29mm, and $n_D^{25}=1.5892$.⁸

p-Bis(diphenylhydrogensilyl)benzene was prepared from the reaction of *p*-dibromobenzene, magnesium, and diphenylchlorosilane.^{3,8,9,10,11} it is a solid with a melting point (mp) of 105-108°C.^{3,8} the infrared spectrum (IR) was described.¹²

These bis-silanes were converted to the bis-silanols by ethanolysis, followed by NaOH hydrolysis;^{2,3,6,8} for example, the bis(dimethylsilyl)benzene was reacted with ethanol containing sodium, then NaOH, and neutralized with potassium dihydrogen phosphate to make bis(dimethylhydroxysilyl)benzene.²

Another method of preparing *p*-bis(hydroxydialkylsilyl)benzene was the Grignard reaction of *p*-dihalobenzene, magnesium, and dichlorodialkylsilane, to make the *p*-bis(chlorodialkylsilyl)benzene, followed by hydrolysis. In the Grignard preparation of bis(chlorodimethylsilyl)benzene with magnesium and dichlorodimethylsilane, it was found that ether was an effective solvent when *p*-dibromobenzene was used.^{4,12,13,14,15} however, when ether was used as the solvent with *p*-dichlorobenzene, then only a mono-reaction took place with magnesium and dichlorodimethylsilane to form *p*-chlorophenyl dimethylchlorosilane. However, if THF was

used as the solvent in this reaction rather than ether, then *p*-bis(chlorodimethylsilyl)benzene was formed.^{16,17} Bis(chlorodimethylsilyl)benzene is a solid; mp=85-86°C, bp=101-102°C/1.0mm⁴ and 150-155°C/19mm. In addition, the Grignard preparation of *p*-bis(chlorodiphenylsilyl)benzene was described, using diphenyldichlorosilane in THF; it is a solid, mp=195-198°C.¹³

Another method described for the preparation of *p*-bis(chlorodimethylsilyl)benzene was the reaction between a disilane and a dihalobenzene. Halophenyl and *p*-halotoluene were converted to the trimethylsilyl derivatives by the reaction of the haloaryl compound with hexamethyldisilane and potassium methoxide in hexamethylphosphoric triamide at 25°C in good yields; the reactivity increases in the order Cl<Br<I.¹⁸ *p*-Dichlorobenzene (10 m-mole), hexamethyldisilane (20 m-mole), and 1% Pd(PPh₃)₂Cl₂, autoclaved 40 hours at 200°C, yielded a 48% yield of *p*-bis(trimethylsilyl)benzene.¹⁹ Under the same reaction conditions the use of 1,2-dichlorotetramethyldisilane resulted in a 53% yield of *p*-bis(chlorodimethylsilyl)benzene.^{20,21}

Chlorobenzenes and hydrosilane reacted to produce HCl and silylbenzene. *p*-Dichlorobenzene and chlorodimethylsilane (mole ratio of 1:3), upon irradiation with 1.5-2.0 MeV electrons in sealed ampoules at 300°C, reacted to produce bis(chlorodimethylsilyl)benzene in a maximum yield of 13%.²² Chlorophenylchlorodimethylsilane and chlorodimethylsilane reacted at 640°C for 60 seconds to produce a 3.8% yield of bis(chlorodimethylsilyl)benzene.²³ However, heating *p*-dichlorobenzene with methylphenylchlorosilane or *p*-chlorophenylmethylchlorosilane at 650°C in a quartz tube yielded up to 25% *p*-bis(phenylmethylchlorosilyl)benzene, a liquid, bp=187-196°C/1-2mm, density 1.1815 g/cm³, n_D²⁰=1.6072.²⁴

p-Bis(chlorodimethylsilyl)benzene was converted to *p*-bis(hydroxydimethylsilyl)benzene by NaOH hydrolysis.¹² by the reaction with ammonium hydroxide in ether;¹⁷ by reaction with ethanol and then NaOH;^{4,6} and by reacting with aqueous NaOH in ether.^{14,15,25,26} For example, the ether solution of the bis-chloro compound reacted with an aqueous solution of alkali at -12°C for 1.5 hours; the aqueous solution of sodium silanolate was neutralized with dilute acetic acid, forming a pure product.²⁷

Another method for the preparation of *p*-phenylenedisilanes was by the Grignard method, using *p*-dibromobenzene, magnesium, and dialkoxydialkylsilanes in ether. Using this method the preparation of bis(ethoxydimethylsilyl)benzene and the corresponding methylvinyl compound was described.¹² THF was found to be the preferred solvent in the Grignard preparation of bis(propoxydimethylsilyl)benzene or the ethoxy compound, from the reaction of *p*-dichlorobenzene, magnesium, and dimethyldipropoxysilane or dimethyldiethoxysilane.^{28,29} Bis(ethoxydimethylsilyl)benzene was hydrolyzed with NaOH to give the bis-silanol.²⁹ Bistalkoxydimethylsilylbenzene was also converted to the corresponding disilanol by reacting with a water-miscible solvent and a small amount of water and refluxing.³⁰ Another method to convert bis(ethoxydimethylsilyl)benzene to the bis-silanol was to react

with BF_3 -etherate to form the bis(dimethylfluorosilyl)benzene, followed by reaction with ammonium hydroxide.³¹

The physical properties of a number of the *p*-bis(hydroxysilyl)benzene compounds were presented.³² These materials are solids. For *p*-bis(dimethylhydroxysilyl)benzene, the melting point is 136-137°C.³³ The IR spectra were described.^{4,27,32} and the nuclear magnetic resonance spectra (NMR) in CCl_4 ⁴ and deuterated DMSO⁶ were presented. For *p*-bis(methylphenylhydroxysilyl)benzene, the IR was presented;^{12,34} the melting point is 128-140°C.^{12,33} and the H^1 NMR was described.¹² For *p*-bis(diphenylhydroxysilyl)benzene, the melting point is 224-226°C,^{12,33} or 226-228°C,⁶ the IR and H^1 NMR were described.³³ For *p*-bis(hydroxymethylvinylsilyl)benzene, the melting point is 95-96°C.²⁹

m-Phenyl Derivatives

m-Bis(dimethylhydroxysilyl)benzene was prepared from the reaction of *m*-dibromobenzene, magnesium, and dimethylchlorosilane in THF; it is a liquid, with a boiling point of 58-59°C/1.1mm, $n_D^{25}=1.4974$, $d_{25}^{25}=0.8703$.⁸ The properties of *m*-bis(ethoxydimethylsilyl)benzene were presented.³³ Hydrolysis of this produced *m*-bis(dimethylhydroxysilyl)benzene, a solid, with a melting point of 81.5-83°C.⁸ *m*-Bis(chlorophenylmethylsilyl)benzene was likewise made; it is a liquid, with a boiling point of 179-185°C/0.07mm. The corresponding disilanol is a solid, with a melting point of 101-102°C; the H^1 NMR was described.³³

The reaction between *m*-dibromobenzene with magnesium and 3,3,3-trifluoropropyl dimethylchlorosilane in THF to prepare *m*-bis(3,3,3-trifluoropropylmethylchlorosilyl)benzene³⁵ and the reaction between *m*-dibromobenzene with magnesium and 3,3,3-trifluoropropylmethylchlorosilane in THF to make *m*-bis(3,3,3-trifluoropropylmethylhydroxysilyl)benzene^{35,36} were described, along with the procedure for hydrolysis of these (using $\text{NaOH}/\text{NaH}_2\text{PO}_4$ solution, with Pd/C) to make the bis-silanol.³⁶ Another preparation of the bis-silanol was the in-situ Grignard reaction of *m*-dibromobenzene, magnesium, and diethoxymethyl-(3,3,3-trifluoropropyl)silane, followed by hydrolysis; for the bis-silanol, the boiling point is 140-142°C/0.1mm.³⁷

Other Bis-Silyl Benzenes

A number of other bis(silyl)benzene derivatives have been prepared by reactions other than the Grignard method. The reaction between chlorophenyl and hydrosilane groups was found to produce HCl and the phenylsilyl group under certain conditions. The reaction between *p*-dichlorobenzene and trichlorosilane at 300°C and 60 atmospheres under cobalt-60 irradiation produced a 50% yield of *p*-bis(trichlorosilyl)benzene; under similar conditions, dimethylchlorosilane produced a monosilylbenzene.^{38,39} Dichlorobenzenes reacted with hydrochlorosilanes (mole ratio 1:3) in sealed ampoules under irradiation with 1.5-2.0 MeV electrons at

300°C. Under these conditions, the reaction between trichlorosilane and either *m*- or *p*-dichlorobenzene produced the corresponding bis(trichlorosilyl)benzene in a yield of around 60%. In the reaction between dichloromethylsilane and dichlorobenzene, the yield of bis(methyldichlorosilyl)benzene was around 50% for the para isomer, 38% for the meta isomer, and 18% for the ortho isomer.²²

Heating *p*-dichlorobenzene and methyldichlorosilane produced bis(methyldichlorosilyl)benzene, along with other products.^{40,41} *p*-Dichlorobenzene/benzene mixture reacted with methyldichlorosilane at 640°C for 30 seconds to produce *p*-bis(methyldichlorosilyl)benzene in a yield of 8%.⁴² *p*-Dichlorobenzene/benzene mixture reacted with trichlorosilane at 640°C and 30 seconds to produce a 15% yield of *p*-bis(trichlorosilyl)benzene.⁴² *p*-dichlorobenzene and trichlorosilane reacted at 620-640°C to form a 21.4% yield of *p*-bis(trichlorosilyl)benzene. Under these same conditions, a mixture of trichlorosilane and (*p*-chlorophenyl)trifluorosilane reacted to produce a 40% yield of 1-trifluorosilyl-4-trichlorosilyl benzene; chlorophenyltrifluorosilane and dichloromethylsilane reacted to produce a 33.3% yield of methyldichlorosilyl trifluorosilyl benzene; trichlorosilane reacted with *p*-chlorophenyltrichlorosilane to produce a 65% yield of *p*-bis(trichlorosilyl)benzene; and chlorophenyltrichlorosilane and dichloromethylsilane reacted to produce a 52% yield of methyldichlorosilyl trichlorosilyl benzene.⁴³

A number of reactions between equimolar mixtures of chlorohydrosilanes and chloroarylalkylchlorosilanes were conducted at 640°C for 60 seconds. The reaction between trichlorosilane and chlorophenyltrichlorosilane produced a 48% yield of bis(trichlorosilyl)benzene.²³ dichlorochlorophenylmethylsilane and trichlorosilane produced a 40.2% yield of 1-(dichloromethylsilyl)-4-(trichlorosilyl)benzene; chlorophenylchlorodimethylsilane and trichlorosilane produced a 15% yield of 1-trichlorosilylbenzene; chlorophenylmethyldichlorosilane and chlorodimethylsilane produced a 3.8% yield of 1-dichloromethylsilyl-4-chlorodimethylsilylbenzene; chlorophenyltrimethylsilane and trichlorosilane produced a 6.5% yield of 1-trimethylsilyl-4-chlorosilylbenzene and a 4.3% yield of 1-chlorodimethylsilyl-4-trichlorosilylbenzene; chlorophenyltrimethylsilane and methyldichlorosilane produced a 5.6% yield of (trimethylsilyl)-dichloromethylsilylbenzene and an 8% yield of (chlorodimethylsilyl)-methyldichlorosilylbenzene.²³

Heating dichlorodiphenylsilane to 500°C resulted in a 10.69% yield of *p*-chlorodiphenylsilyl-phenyldichlorosilyl benzene.⁴⁴ Heating phenyltrichlorosilane to 720°C resulted in a 25.25% yield of higher boiling materials that consisted of bis(chlorophenyl)silyl benzenes,⁴⁵ and heating phenyldichlorosilane to 450-550°C for 8 hours resulted in dichlorophenylsilyl dichlorosilyl benzene and higher-boiling derivatives. Heating a 1:1 molar mixture of phenyldichlorosilane and methyldichlorosilane resulted in a residue containing (methyldichlorosilyl)dichlorosilylbenzene.⁴⁶

In the reaction between an arylsilane and a chlorohydrosilane catalyzed by BCl_3 , a hydrogen in the phenyl group is replaced by the chlorosilyl group, forming a silicon-phenyl bond.^{47,48,49} In the direct synthesis preparation of phenyl

trichlorosilane and diphenyldichlorosilane from the BCl_3 -catalyzed reaction of benzene and trichlorosilane, there were stillpot residues containing, among other substances, bis(trichlorosilyl)benzene and phenyldichlorosilyl trichlorosilyl benzene resulting from further reaction of the desired product with HSiCl_3 ;⁵⁰ this residue constituted 5-10% of the products of this reaction.⁵¹ If an excess of trichlorosilane was used in this reaction, there was a greater yield of bis(trichlorosilyl)benzene.^{52,53} The reaction between phenyltrichlorosilane and trichlorosilane produced primarily bis(trichlorosilyl)benzene, some phenyldichlorosilyl trichlorosilyl benzene, and a smaller amount of bis(trichlorosilylphenyl)dichlorosilane.^{47,48,49}

For the reaction between hydrochlorosilanes and aryl materials, BCl_3 was found to be the best catalyst, compared to AlCl_3 and others. The reaction between benzene and methyldichlorosilane with BCl_3 catalyst produced the expected phenylmethyldichlorosilane; but, at temperatures above 240°C , further reactions between the phenyl and the silane took place, producing substantial stillpot residues.^{48,49} Heating diphenyldichlorosilane with AlCl_3 at 210 to 250°C for 4 hours resulted in a reaction between the phenyl and the chlorosilyl group producing bis(dichlorophenylsilyl)benzene and polydichlorosilphenylenes.⁵⁴ Heating chlorobenzene with trichlorosilane in the presence of BCl_3 or AlCl_3 produced some chlorophenyl trichlorosilane and also some distillation residue containing bis(trichlorosilyl)chlorobenzene.⁵⁵

XYLYL DERIVATIVES

p-Xylyl Derivatives

The preparation of *p*-bis(hydrogendimethylsilyl)xylene by the Grignard reaction of xylene dibromide with dimethylchlorosilane and magnesium in THF was described; it is a liquid, with a boiling point of $81^\circ\text{C}/0.8\text{mm}$, $n_D^{25}=1.5002$, $d_{25}^{25}=0.8203$.^{3,8} This was converted to the bis-silanol by basic hydrolysis; the bis-silanol is a solid, with a melting point of $121-122^\circ\text{C}$.⁸

m-Xylyl Derivatives

To prepare *m*-bis(dimethylhydroxysilyl)xylene, *m*-xylene was first brominated with *N*-bromosuccinimide in CCl_4 under UV irradiation to make dibromo-*m*-xylene. This reacted with dimethyldichlorosilane and magnesium in THF to make *m*-bis(dimethylhydrogensilyl)xylene; this reacted with sodium ethoxide and then NaOH to make the desired bis-silanol. Physical properties of these, including IR, NMR, boiling point, etc., were presented. The bis(methylphenylhydrogenosilyl) derivative was made similarly from *m*-xylene and methylphenylchlorosilane. The IR, NMR, and physical properties of these materials were presented.⁵⁶

Other Xylyl Derivatives

The reaction between chloromethyltrichlorosilane and benzene, at reflux in the presence of AlCl_3 , produced a 75% yield of *o*-, *m*-, and *p*-bis(trichlorosilylmethyl)benzene.⁵⁷

TOLUENE DERIVATIVES

2,4-Bis(dimethylchlorosilyl)toluene was made in a Grignard reaction, consisting of the reaction of 2,4-dibromotoluene and dimethyldichlorosilane and magnesium in ether. It is a liquid, with a boiling point of 105-107°C/1.5mm.⁵⁸

p-DIPHENYL DERIVATIVES

The Grignard preparation of *p*-bis(hydrogendimethylsilyl)diphenyl by the reaction of the diphenyldibromide with dimethylchlorosilane and magnesium in THF was described; it is a liquid, with a boiling point of 140-141°C/85mm, $d_{25}^4=0.963$, $n_D^{25}=1.4724$.^{3,8} This was converted to the corresponding bis-silanol by ethanolysis, followed by NaOH hydrolysis. The bis-silanol is a solid, with a melting point of 176-180°C.⁸ The Grignard preparation of 4,4-bis(ethoxydiphenylsilyl)biphenyl and 4,4-bis(methoxydiphenylsilyl)biphenyl and the properties of these materials were described.⁵⁹ 4,4'-Dibromodiphenyl *o*-diphenyl ether reacted with butyllithium to form the dilithio derivative, this reacted with dichlorodimethylsilane to produce 4,4'-bis(chlorodimethylsilyl)diphenyl *o*-diphenyl ether.⁶⁰ 4,4'-Biphenyl dilithium was used in the preparation of 4,4'-bis(methoxydiphenylsilyl)biphenyl; the properties were described.⁵⁹

Biphenyl and trichlorosilane (1:4 mole ratio, 300°C, BCl_3 catalyst) reacted to produce a 31.2% yield of monosilyl adduct and a 20.7% yield of disilyl adduct.⁵³

p-DIPHENYL ETHER DERIVATIVES

p-Bis(hydrogendimethylsilyl)diphenyl ether was prepared by the Grignard reaction of *p*-dibromodiphenyl ether with dimethylchlorosilane and magnesium in THF; it is a liquid, with a boiling point of 132°C/5mm, $n_D^{25}=1.5478$, $d_{25}^4=0.976$.^{3,8} This was converted to the corresponding bis-silanol by ethanolysis, followed by NaOH hydrolysis.⁸ *p*-Bis(ethoxydimethylsilyl)diphenyl ether was prepared from *p*-dibromodiphenyl ether, followed by ethanolysis and NaOH reaction to form the bis-silanol.^{6,29} The IR was presented.³⁴ This bis-silanol is a solid, with a melting point of 103-104°C, the ^1H NMR was presented.³³

p-Bis(bromophenyl)ether reacted with chlorodimethylethoxysilane in sodium to produce bis(*p*-dimethylethoxysilylphenyl) ether. This was hydrolyzed with NaOH solution to form the bis-silanol.^{33,34}

materials. Dichlorodimethylsilane reacted with this complex to make polydimethylsilmethylenes.¹⁴⁷ The reaction between silicon, containing 10% copper, with methylene chloride in a nitrogen stream at 300°C, produced a small fraction of residue consisting of polydichlorosilmethylene, along with trichlorosilyl dichlorosilylmethane, bis(trichlorosilyl)methane, dichlorosilmethylene trimer.¹⁴⁸

PHYSICAL PROPERTIES OF POLYSILMETHYLENES

Polydimethylsilmethylenes of molecular weight 6,000,000 were announced; they were described as elastomers.¹⁴⁹ Various physical properties of polydimethylsilmethylene were presented.⁹⁸ The polymer physics of polydimethylsilmethylene were described.¹⁵⁰ The gums produced from the polymerization of 1,1,3,3-tetramethyl-1,3-disilacyclobutane, using cyclohexene platinous chloride complex, were cured with dicumyl peroxide; they were compounded with ground quartz and fume silica; the procedure was described. Rubber samples with an ultimate tensile strength of 650 psi and a corresponding elongation of 320% were made. This rubber maintained satisfactory properties after heating at 150°C for 20 hours.¹⁵¹ In another study, the elastomer was formulated with fume silica and ground quartz, cured with dicumyl peroxide to give sheets of rubber that possessed nearly uniform tensile properties between -78°C and 150°C. For these rubber samples, the ultimate elongation was in the range of 200-350%, and the hardness was in the range of 40-45 BS.¹²⁷ Polymethylphenylsilmethylene varied in properties from a clear, tough rubber to a glassy resin, depending upon DP. Copolymers of dimethyl and methylphenyl silmethylene were generally rubbery.¹²⁵

The thermal depolymerization of polydimethylsilmethylene requires a substantially higher activation energy than does polydimethylsiloxane, as it does not have the same low-energy path for decomposition; however, the depolymerization of silmethylenesiloxane silethylene-siloxane polymers was found similar to that of polydimethylsiloxane.¹⁵² Polydimethylsilmethylene is more thermally stable, and more resistant to alkalis and acids than the corresponding polysiloxane.¹⁴⁰ The thermal stability in helium is good, with 10% weight loss at 600°C for a sample precipitated from hexane solution.¹²⁶ For a polydimethylsilmethylene of molecular weight 500,000, the TGA in nitrogen indicated substantial thermal stability; the weight loss in 30 minutes was 1.1% at 400°C and 2.0% at 450°C.¹²⁷ This polymer can withstand 420 C, and has been recommended for use as a gas chromatography stationary phase.¹⁵³

Polydimethylsilmethylene is not very stable to oxidation;¹²⁷ oxidative thermal degradation was found to take place at temperatures less than 300°C.¹²⁶ For polysilmethylenes containing both methyl and phenyl groups, the oxidative thermal stability increased with the phenyl content, for example, the TGA onset temperature in air for polydimethylsilmethylene was 260 C, for a polysilmethylene containing one phenyl group for every three methyl groups, the corresponding temperature was 290 C. For polymethylphenylsilmethylene, a stiff material, the Tg was 18°C and the

ranging from 400,000 to 4,000,000.^{132,133} The thermal polymerization was studied, and a kinetic equation was derived. It was found that the molecular weight of the resulting polymer increased with reaction temperature in the range 140-240°C, and time in the range 1.5 to 5 hours. When the temperature was held at 160°C, the conversion of monomer to polymer increased, not only with time, but with monomer concentration in toluene solution.¹³⁴ At 320°C, the monomer polymerized to a white, elastomeric substance. When heated to 380-400°C for 3.5 hours, the cyclic trimer, hexamethyltrisilacyclohexane, polymerized to a rubbery material.¹³⁵ 1,1,3,3-Tetramethyl-1,3-disilacyclobutane polymerized at 300°C (1.5 hours, 400 psi) to a polymer of degree of polymerization (DP) of around 200;¹¹⁹ in another effort, using the same experimental conditions, a viscous oil of molecular weight 15,000 was produced, and other 1,3-disilacyclobutanes were also polymerized.^{103,104}

1,1,3,3-Tetraphenyl-1,3-disilacyclobutane polymerized upon heating to 180-200°C, 2-4 hours, to make a white powder with a crystalline melting point of 340°C.¹³⁶

METAL COUPLING REACTIONS

Low-molecular-weight polydimethylsilmethylene was made by reacting a mixture of dichlorodimethylsilane and chloromethyldimethylchlorosilane with sodium in refluxing toluene. This reaction also took place if ethoxy groups were substituted for chlorine.¹³⁷ The reaction of chloromethyldimethylchlorosilane with magnesium produced chloride-terminated dimethylsilmethylene oligomers; the lower homologs, DP 1-4, could be distilled out, leaving higher molecular-weight residue. Zinc or sodium could be substituted for magnesium in this reaction.¹³⁸ Chloromethyldimethylchlorosilane, containing minor amounts of bis(chloromethyl)methylchlorosilane, reacted with sodium in toluene to make viscous polydimethylsilmethylene oligomers.¹³⁹ Bis(chloromethyl)dimethylsilane and bis(chlorodimethylsilyl)methane reacted with sodium in toluene, under reflux, to form polydimethylsilmethylene macrocycles.¹⁴⁰ It was stated that the polydimethylsilmethylenes produced were cyclic compounds.¹⁴¹

Chloromethyldialkylchloro- (or ethoxy-) silanes react with molten sodium to make carbosilane polymers. For example, sodium, added to chloromethyldimethyl-ethoxysilane under reflux, produced a variety of products, including a residue that was an oil of molecular weight 562. Chloromethyldimethylchlorosilane reacted with sodium in xylene at 110°C to produce a viscous oil. This oil was distillable above 350°C, indicating the high thermal stability. Likewise prepared were methylphenyl- and methylbutyl-carbosilane polymers.^{142,143} This process was modified by adding trimethylsilyl chloride or ethoxide; physical properties of a number of these materials were presented.^{144,145,146}

Aluminum containing 3% copper reacted with methylene chloride to form a viscous complex. This complex reacted with trimethylchlorosilane to form various products, including the dimer and trimer of dimethylsilmethylene and high-boiling

bulk compared to solution polymerization. Other disilacyclobutanes were also polymerized; under these conditions, methoxymethyl- and chloromethylsilmethylene polymers were generally viscous liquids.¹²⁵ These were polymerized with chloroplatinic acid catalyst under several conditions. In the presence of 10% water, only a low-molecular weight polymer was formed in poor yield, but in the presence of 17-23 ppm platinum catalyst, bulk polymerization produced polymers rather rapidly at 100°C, of molecular weight greater than 100,000; a mechanism for the polymerization was discussed.¹²⁶ When Pt/C was used as catalyst at 90°C, the polymerization proceeded exothermally, raising the reaction vessel temperature to 150°C. The polydimethylsilmethylene was clear and pliant, resembling polyisobutylene.¹²⁶ Other types of disilacyclobutanes were also polymerized under these conditions.¹²⁴

Using di- μ -chlorodichlorobis(cyclohexene)diplatinum (II) catalyst, copolymers can be produced from 1,1,3,3-tetramethyl-1,3-disilacyclobutane and other 1,3-disilacyclobutanes. Other disilacyclobutanes that polymerized to high molecular weight were 1,3-diethoxy-1,3-dimethyl-1,3-disilacyclobutane and 1,3-diphenyl-1,3-dimethyl-1,3-disilacyclobutane. Under the same reaction conditions, 1,1,3,3,5,5-hexamethyl-1,3,5-trisilacyclohexane and 1,1,3,3,5,5,7,7-octamethyl-1,3,5,7-tetrasilacyclooctane did not polymerize.¹²⁷ 1,1,3-Trimethyl-3-(3,3,3-trifluoropropyl)-1,3-disilacyclobutane was polymerized by heating to 100°C in the presence of 28 ppm chloroplatinic acid to a polymer of Mw=150,000; this polymer was peroxide-cured to an elastomer that had superior solvent swelling resistance, compared to polydimethylsilmethylene.¹²⁶

Catalysts containing platinum or other transition metal compounds were used in concentrations 1 part catalyst to 500 parts monomer. For example, the use of chloroplatinic acid at 70°C for 2 minutes resulted in a liquid polydimethylsilmethylene of viscosity 300 cS; the use of di- μ -chloro-dichlorobis(cyclohexene)diplatinum as catalyst at 70°C and 5 minutes resulted in a gum. The use as catalysts of PtBr₂ (70°C, 2 minutes), PdBr₂, RuCl₃, and others produced gums. 1,3-Diethoxy-1,3-dimethyl-1,3-disilacyclobutane was also polymerized.¹²⁸

π -Crotlyl nickel chloride was used as a catalyst for this polymerization, in concentrations less than 1%, at temperatures of 35-50°C, in toluene solvent. Polymers of intrinsic viscosity greater than 1 dl/g were produced in some cases.¹²⁹ The salts of a number of transition elements were also studied as polymerization catalysts; found effective were AuCl₃, CuCl₂, and CuCl, in concentrations around 1%; the conditions were 90°C, time 1-12 hours. Polydimethylsilmethylenes with intrinsic viscosities as high as 3.2 dl/g were prepared.¹³⁰ AlCl₃ also polymerized the ring-opening polymerization of silacyclobutanes.¹³¹

THERMAL RING-OPENING POLYMERIZATION

Under very dry conditions, at temperatures to 250°C for 6 hours, 1,1,3,3-tetramethyl-1,3-disilacyclobutane polymerized to elastomers with molecular weights

1,1-dimethyl-1-silacyclobutane, passed through a quartz tube heated to 600°C produced 1,1,3,3-tetramethyl-1,3-disilacyclobutane in 55% yield, with ethylene as by-product. Likewise, 1,1-dichloro-1-silacyclobutane, when heated to 680°C, produced 1,1,3,3-tetrachloro-1,3-disilacyclobutane in high yield.^{110,111} In the former reaction, $(\text{CH}_3)_2\text{Si}=\text{CH}_2$ is believed to be the intermediate.^{112,113} Heating 1,1,3-trimethyl-1-silacyclobutane resulted in propene and 1,1,3,3-tetramethyl-1,3-disilacyclobutane. Literature methods to prepare 1,1-dimethyl-1-silacyclobutane by ring closure to allyldimethylsilane have been unsuccessful; catalysts tried were Pt/C¹¹⁴ and chloroplatinic acid.¹¹⁵

The gas-phase flow pyrolysis at 700°C and pressures less than 700 microns of 1,2-dimethoxy-tetramethyldisilane gave, as major products, 1,1- and 1,3-dimethyl-1,3-disilacyclobutanes in yields of 10% and 17%.¹¹⁶

Pyrolysis of tetramethylsilane at 700°C produced 1,1,3,3-tetramethyl-1,3-disilacyclobutane in 3.2% yield.^{117,118,119}

PHOTOLYSIS METHODS

1,1,3,3-tetramethyl-1,3-disilacyclobutane was produced in the mercury sensitized photolysis of tetramethylsilane; theorized was the formation of $(\text{CH}_3)_2\text{Si}=\text{CH}_2$, which dimerized.¹²⁰ It was produced in 30% yield by liquid-phase photolysis of tetramethylsilane.¹²¹

ALKALI METAL METHODS

Bis(chloromethyl)dimethylsilane reacted with lithium in ether to form the dilithio derivative; dimethyldichlorosilane was added to the ether mixture and left overnight at room temperature. Distillation of the products indicated a 24% yield of 1,1,3,3-tetramethyl-1,3-disilacyclobutane.¹²² The reaction between t-butyllithium and vinyldimethylchlorosilane produced 46% of 1,1,3,3-tetramethyl-2,4-dineopentyl-1,3-disilacyclobutane; yields of 80% can be obtained by warming the reactants from -78°C.¹²³

POLYSILMETHYLENES

CATALYZED RING-OPENING POLYMERIZATION

1,1,3,3-tetramethyl-1,3-disilacyclobutane was polymerized with chloroplatinic acid catalyst.^{98,124} It polymerized in bulk with chloroplatinic acid solution, 0.01 mole ratio, 25°C, to a rubber with Mw of 200,000. Other catalysts of platinum were also effective. It was found that higher polymer molecular weight resulted in

In another preparation, a solution of chloromethyldimethylchlorosilane in THF was slowly added to magnesium in THF; the mixture was refluxed 12 hours, decanted, and added to HCl solution; ether was added, and the organic layer was dried and distilled. In this procedure, 1,1,3,3-tetramethyl-1,3-disilacyclobutane was produced in 20% yield, it is a liquid, bp=115-117°C, $n_D^{20}=1.4412$.¹⁰¹ Another preparation involved the reaction of 1-chloromethyl-3-chlorodisilmethylene in THF with magnesium in THF, refluxing 5 hours; 1,1,3,3-tetramethyl-1,3-disilacyclobutane was produced in 65% yield.¹⁰² Other Grignard methods for the preparation of 1,1,3,3-tetramethyl-1,3-disilacyclobutane were also described.^{103,104,105}

Other disilacyclobutanes were prepared, and their physical properties listed: 1,3-dichloro-1,3-dimethyl-1,3-disilacyclobutane and others.⁹⁹ The Grignard method of reacting chloromethylmethyldichlorosilane with magnesium to make 1,3-dimethyl-1,3-dichloro-1,3-disilacyclobutane was described; this reacted with $LiAlH_4$ to make 1,3-dimethyl-1,3-disilacyclobutane, and reacted with phenylmagnesium bromide to make 1,3-dimethyl-1,3-diphenyl-1,3-disilacyclobutane.¹⁰⁰ The preparation of chloromethylmethylethoxychlorosilane was described; using the above-described Grignard method, 1,3-diethoxy-1,3-dimethyl-1,3-disilacyclobutane was made, and the properties were described.^{99,100}

Reacting chloromethyldimethylchlorosilane with magnesium produced 1,1,3,3-tetramethyl-1,3-disilacyclobutane; reacting chloromethyldiphenylchlorosilane or chloromethylmethylphenylchlorosilane with magnesium resulted in 1,1,3,3-tetraphenyl-1,3-disilacyclobutane or 1,3-dimethyl-1,3-diphenyl-1,3-disilacyclobutane; likewise, chloromethyltrichlorosilane produced 1,1,3,3-tetrachloro-1,3-disilacyclobutane; the propoxy analog was also prepared.¹⁰⁶ Reacting chloromethylmethylphenylchlorosilane with magnesium resulted in 1,3-dimethyl-1,3-diphenyl-1,3-disilacyclobutane; reacting chloromethyldimethylchlorosilane mixed with chloromethylmethyldichlorosilane with magnesium produced 1,1,3-trimethyl-3-chloro-1,3-disilacyclobutane; reacting this with phenylmagnesium bromide or allylmagnesium bromide resulted in the corresponding monophenyl or monoallyl disilacyclobutane; physical properties of these monomers were presented.¹⁰⁷

To make fluoroalkyl-substituted silacyclobutane and polyfluoroalkylsilmethylenes, the method of preparation of the silacyclobutanes is to add a mixture of chloromethyldimethylchlorosilane and chloromethylmethyldichlorosilane to magnesium, to make the chloromethylsilacyclobutane, and to treat this with bromofluorocarbon, such as 1,1,1-trifluoro-3-bromopropane, and magnesium; in that case, 3-(3,3,3-trifluoropropyl)-1,1,3-trimethyl-1,3-disilacyclobutane was produced. Likewise, the dimethyl-di(3,3,3-trifluoropropyl) analog was made, along with the corresponding polymer.¹⁰⁸

THERMOLYSIS METHODS

Several studies have shown that 1,1-dimethyl-1-silacyclobutane, when heated, produced 1,1,3,3-tetramethyl-1,3-disilacyclobutane.^{109,110} For example,

A number of the trifluoropropyl-containing copolymers were prepared. These were shown to be superior in solvent resistance, compared to the all-methyl polymers; however, the Tgs were higher, and the TGA decomposition temperatures were substantially lower than the all-methyl polymers.^{93,94}

BIS(*p*-DIMETHYLHYDROXYSILYLPHENYL)DIMETHYLSILANE DERIVATIVES

Bis(*p*-dimethylhydroxysilylphenyl)dimethylsilane was prepared from the Grignard reaction of dichlorodimethylsilane and bis(*p*-bromophenyl)dimethylsilane to form the bis-chloro analog; this was converted to the bis-hydroxy derivative and then polymerized in the presence of KOH to the homopolymer, a clear elastic solid that could be mixed with fillers and peroxide-cured.^{78,96}

POLYSILPHENYLENES

The di-Grignard reaction of 1,4-dibromobenzene with diphenyldichlorosilane in THF/benzene at -80°C to produce polydiphenylsilphenylene was described.⁷⁸ Polydiphenylsilphenylene was made also from the reaction of *p*-dibromobenzene, diphenyldichlorosilane with sodium in refluxing xylene, and from the reaction of diphenyldichlorosilane with *p*-phenylenedimagnesium dibromide, in ether. The polymer is a brown resin.⁹⁷ Polydimethylsilphenylene and polydiphenylsilphenylene were made from the reaction of sodium and either *p*-chlorophenylchlorodimethylsilane or *p*-chlorophenylchlorodiphenylsilane. Properties, including TGA, of these polymers were described; decomposition temperatures (onset) above 400°C were noted; thermal stability increased with molecular weight. However, none of these were elastomeric.¹³

DISILACYCLOBUTANES

GRIGNARD PREPARATIONS

To prepare 1,1,3,3-tetramethyl-1,3-disilacyclobutane, a solution of chloromethyl-dimethylchlorosilane in THF was slowly added to a small amount of magnesium in THF, and more magnesium was gradually added, with temperature held to 30-50°C; a yield of 35% was reported.⁹⁸ Using the same procedure, a yield of 49.9% and physical properties were reported.⁹⁹ Also reported in using this procedure was a 35% yield of 1,1,3,3-tetramethyl-1,3-disilacyclobutane, and some of the cyclic trimer as by-product.¹⁰⁰ In addition, there was reported as by-product some viscous residue consisting of higher cyclic and linear polydimethylsilphenylenes.⁹⁹

alternating copolymers of the bis-silanol and tetramethyldisiloxane; intrinsic viscosities to 3.5 dl/g were found. The polymers were cured with *t*-butylperoxybenzoate, and milled with silica and ferric oxide. For some of these cured elastomers, ultimate stress to 600-800 psi, with corresponding strain to 50-150%, was found. TGA measurements of these polymers showed thermal stability above 300°C.^{29,91}

TGA studies of alternating copolymers of the bis-silanol and dimethylsiloxane, tetramethyldisiloxane, and the corresponding tri- and tetrasiloxanes have shown that there is greater thermal stability for fewer dimethylsiloxane units; although, even with the tetrasiloxane copolymer, the thermal stability is substantially greater than that of polydimethylsiloxane. In comparing the thermal stability of aryl moieties, for copolymers containing hexamethyltrisiloxane units, the diphenyl ether moiety was found to be the most stable, followed by the *p*- and then *m*-phenylene. All of these were found to have TGA onset temperature of thermal degradation greater than 400°C.^{34,92}

m-XYLYL DERIVATIVES

α,α' -Bis(dimethylhydroxysilyl)-*m*-xylene was homopolymerized, using as catalysts either *n*-hexylamine-2-ethylhexanoate or 1,1,3,3-tetramethylguanidine. Molecular weight for the homopolymer obtained from the former catalyst was 38,800; for the latter catalyst, 3400. For the former polymer, TGA measurements showed 10% weight loss at around 530°C in nitrogen and around 300°C in air.⁵⁶ In using 1,1,3,3-tetramethylguanidine-2-ethylhexanoate as homopolymerization catalyst, the resulting homopolymer had an intrinsic viscosity in toluene of 0.51 dl/g and a molecular weight of 41,700. If ferric chloride was used as catalyst, rather low molecular weights of polymer were obtained.

To prepare alternating copolymers containing dimethylsiloxane or tetramethyldisiloxane groups, either bis(dimethylamino)dimethylsilane or bis(dimethylamino)tetramethyldisiloxane was reacted with the bis-silanol, either neat or in solution.^{93,94} These alternating copolymers were also prepared by the condensation of the bis-silanol with diacetoxysilanes, resulting in dimethylsiloxane and tetramethyldisiloxane copolymers of intrinsic viscosities between 0.5 and 1.0 dl/g.⁸³

TGA data indicated that the homopolymer, dimethylsiloxane copolymer, and hexamethyldisiloxane copolymer were all substantially more stable than polydimethylsiloxane, with the dimethylsiloxane copolymer the most stable. The homopolymer is elastomeric, and is more thermally stable than the *p*- or *m*-bis(dimethylhydroxysilyl)benzene homopolymers. For the homopolymer, the T_g was -41°C; for the tetramethyldisiloxane copolymer, the T_g was -81°C. These polymers were cured with di-*t*-butyl peroxide or with dicumyl peroxide.^{93,94} For the copolymer with dimethylsiloxane, the polymer of intrinsic viscosity 0.355 dl/g in benzene, the M_n was 14,500 the T_g was -62°C, and from TGA measurements, the decomposition temperature at 10% weight loss was 537°C. For the tetramethyldisiloxane copolymer, TGA measurements indicated the temperature of 10% weight loss at 598°C.^{93,95}

Another method of making the fluorine-containing copolymer was the reaction of *m*-bis(3,3,3-trifluoropropylmethylhydroxysilyl)benzene and 1,3-diacetoxy-1,3-dimethyl-1,3-bis(3,3,3-trifluoropropyl)disiloxane (prepared from acetic anhydride and the corresponding cyclotrisiloxane), catalyzed by tetramethylenediamine, and subjected to further heating with tetramethylguanidine trifluoroacetate; polymers of $M_n=15,659$ and $M_w=106,000$ were made. The reverse reaction, using bis(acetoxy)-*m*-silphenylene was also conducted. Copolymer of lower molecular weight was made from the *m*-bis-silanol and the corresponding dichlorodisiloxane. The reaction of *m*-bis(3,3,3-trifluoropropylmethylhydroxysilyl)benzene and trifluoropropylmethylchlorosilane produced *m*-bis(1,3-dimethyl-1,3-bis(3,3,3-trifluoropropyl)disiloxanyl)benzene, the properties were presented. This reacted with NaOH/NaH₂PO₄ in dioxane, in the presence of lead and carbon, to give the corresponding bis-silanol; this bis-silanol was homopolymerized. Properties of these materials, including the IR spectrum, were presented.³⁵ The Grignard reaction of *m*-dibromobenzene and trichloro(trifluoropropyl)silane to make bis(trifluoropropyl-dichlorosilyl)benzene was described; this reacted with chlorodimethylsilane in the presence of water to make *m*-bis((dimethylsiloxy)trifluoropropylhydrogenosilyl)benzene, hence called "crosslinker".³⁵ Further studies were conducted on the homopolymerization of *m*-bis(1,3-dimethyl-1,3-bis(3,3,3-trifluoropropyl)disiloxanyl)benzene to form the hydroxy-terminated polymers. These polymers were vinyl-terminated by reacting with vinyl dimethylsilylisocyanate, and cured, using "crosslinker" and platinum catalyst. Various formulations were described, where silica, ferric oxide, and other materials were added; tensile and other properties were presented.⁹⁰

p-DIPHENYL ETHER DERIVATIVES

The preparation of exactly alternating copolymers from bis(hydroxydimethylsilyl)diphenyl ether and dimethylsiloxane, methylvinylsiloxane, and mixtures was done by reacting the bis-silanol with bis(1,1-tetramethylene-3-phenylureido)dimethylsilane and bis(1,1-tetramethylene-3-phenylureido)methylvinylsilane; various polymers of M_w over 100,000 were made.^{6,80,84} For these polymers, the ¹H and ¹³C NMR, the IR spectra, the T_g and TGA were determined. The T_g was -42°C and the onset of thermal degradation by TGA was 335°C in air and 470°C in nitrogen for dimethylsiloxane copolymer; for the methylvinylsiloxane copolymer, the T_g was -51°C, and the onset temperature of thermal degradation by TGA was 425°C in air and 490°C in nitrogen. pyrolysis studies showed gas evolution above 400°C.⁶

These alternating copolymers were also prepared from the reaction of *p*-bis(dimethylhydrogensilyl)diphenyl ether with diacetoxyxilanes, including dimethyl-diacetoxyxilane and tetramethyl-1,3-diacetoxydisiloxane, and these polymers had intrinsic viscosities between 0.5 and 1.0 dl/g.⁸³ A large number of copolymers were made, using *p*-bis(dimethylsilyl)diphenyl ether, with small amounts of *p*-bis(methylvinylhydroxysilyl)benzene, reacting with either heptamethyl-1,3-dioxo-5-aza-2,4,6-trisilacyclohexane to make alternating copolymers of the bis-silanol and hexamethyl-trisiloxane, or decamethyl-1,5-dioxo-3,7-diaza-2,4,6,8-tetrasilacyclooctane to make

rubber materials, using silica, partially hydrolyzed ethyl silicate, and dibutyltin diacetate were described.²⁵

Copolymers With *p*-Bis(methylphenylhydroxysilyl)benzene

1,2-Dimethyl-1,2-diphenyldisiloxane copolymer was prepared by reaction of the bis-silanol and (SiMePh-O-SiMePhNMe)₂ in xylene reflux. The polymer was a tacky gum: inherent viscosities (toluene, 30°C) of 0.07 to 0.13 dl/g were obtained.¹²

Copolymers With *p*-Bis(diphenylhydroxysilyl)benzene

The hexamethyltrisiloxane copolymer was prepared from the bis-silanol and heptamethyl-1-aza-3,5-dioxa-2,4,6-trisilacyclohexane; it was an elastomer. The 1,2-diphenyl-1,2-dimethyltetrasiloxane copolymer, a hard and brittle polymer, was prepared from the reaction of the bis-silanol with (SiMePh-O-SiMePhNMe)₂ in toluene and in xylene reflux.¹² The diphenylsiloxane copolymer, a brittle solid, was prepared from the reaction of the bis-silanol and diphenylbis(methylamino)silane,¹² or from the reaction of the bis-silanol with diphenyldichlorosilane in THF in the presence of pyridine.⁸⁸

m-PHENYLENE DERIVATIVES

m-Bis(dimethylhydroxysilyl)benzene and *m*-bis(methylphenylhydroxysilyl)benzene were both reacted with heptamethyl-1-aza-3,5-dioxa-2,4,6-trisilacyclohexane at 160°C for 8 hours to make the corresponding hexamethyltrisiloxane copolymers. For the dimethyl copolymer, the inherent viscosity was 1.60 dl/g (toluene, 30°C) and the T_g was -75°C; for the methylphenylsiloxane copolymer, the inherent viscosity was 1.62 dl/g, and the T_g was -42°C.³⁴

In the search for thermally stable, fuel-resistant elastomers for aircraft tank sealants, silphenylene-siloxanes containing the 1,1,1-trifluoropropyl group, called FASIL polymers, were developed. The ethoxy precursor, *m*-bis(3,3,3-trifluoropropylmethylethoxysilyl)benzene, was homopolymerized by hydrolysis. This polymer had a T_g of -23°C and a Mw of 17,457. In making FASIL polymers, the condensation polymerization reaction between *m*-bis(3,3,3-trifluoropropylmethylethoxysilyl)benzene and bis(dimethylamino)-1,3-dimethyl-1,3-bis(3,3,3-trifluoropropyl)disiloxane, catalyzed by tetramethyl guanidine trifluoroacetate, was described.³⁵ In a similar effort, 12.8 m-moles of 1,3-bis(hydroxymethyl-3,3,3-trifluoropropyl silyl)benzene, 11.16 m-moles of 1,3-dimethyl-1,3-bis(3,3,3-trifluoropropyl)-1,3-bis(dimethylamino) disiloxane and .36 m-moles of methylvinylbis(dimethylamino)silane were refluxed in toluene, producing a copolymer of Mw = 3700.^{37,89}

presented; the inherent viscosity (toluene, 30°C) was 0.73 dl/g and the T_g was -62°C. The TGA was presented;³⁴ the inflection temperature was 510°C.⁶

Hexamethyltrisiloxane Copolymer. The hexamethyltrisiloxane copolymer was prepared by the reaction of the bis-silanol with heptamethyl-1-aza-3.5-dioxa-2.4.6-trisilacyclobutane at 160°C for 8 hours. The IR was presented; the inherent viscosity (toluene, 30°C) was 2.77 dl/g and the T_g was -72°C.³⁴

Octamethyltetrasiloxane Copolymer. The octamethyltetrasiloxane copolymer was prepared from the reaction of the bis-silanol with nonamethyl-1-aza-3.5.7-trioxa-2.4.6.8-tetrasilacyclooctane at 160°C for 8 hours. The inherent viscosity (toluene, 30°C) was 2.48 dl/g and the T_g was -80°C; the IR was presented.³⁴

Methylphenylsiloxane Copolymer. The methylphenylsiloxane copolymer was prepared from the reaction of the bis-silanol with diacetoxymethylphenylsilane, using triethylamine catalyst; inherent viscosity (THF, 25°C) was 0.38.⁸³ The relationship between intrinsic viscosity and molecular weight in THF is given as $\eta = 5.34 \times 10^{-5} \text{ Mw}^{0.799}$; T_g = -25°C.⁶ Also made by this acetoxy-hydroxyl condensation was the copolymer of the disilanol with 1,2-dimethyl-1,2-diphenyl-disiloxane; intrinsic viscosity was 0.41 dl/g.⁸³

Copolymers containing methylphenyl, dimethyl, and methylvinylsiloxane, where the mole ratio of the sum of these is equal to the mole ratio of bis-silanol in an alternating copolymer were obtained. These mixed alternating copolymers were prepared from bis-silanol and mixtures of dichlorodialkylsilane in THF at 25°C with nitrogen flowing through to remove HCl.

For 99% methylphenyl/1% methylvinylsiloxane copolymer, the Mw was 51,000 and the T_g was -32°C; the H¹ NMR was presented, and TGA data showed an onset of thermal degradation at 400°C, with leveling off at 650°C, and 52% residue. For 66% methylphenyl/33% dimethyl/1% methylvinyl copolymer, the T_g was -44°C, the Mw was 71,000 and the H¹ NMR was presented; TGA data indicated an onset of thermal degradation at 410°C and a 50% residue at temperatures equal or greater than 660°C. For 33% methylphenyl/66% dimethyl/1% methylvinylsiloxane copolymer, the T_g was -60°C, the Mw was 33,000 and the H¹ and C¹³ NMR were presented, and TGA data showed an onset at 400°C and 37% residue at and above 660°C. For 99% dimethyl/1% methylvinylsiloxane copolymer, the T_g was -65°C. Copolymers containing 98% methylphenyl/2% methylvinylsiloxane were cured with 30 phr hydrophobic silica, 0.5 phr dicumyl peroxide, and 3 phr ferric oxide; mechanical properties were given.^{5,87}

Diphenylsiloxane Copolymer. The diphenylsiloxane copolymer was prepared from the reaction of the bis-silanol with diphenylbis(methylamino)silane either neat¹² or in toluene reflux.²⁵ This copolymer is an elastic gum. The equation between intrinsic viscosity and Mw is $\eta = 5.7 \times 10^{-5} \text{ Mw}^{0.75}$; for this polymer, the T_g was 0°C, and TGA showed a 10% weight loss at 460°C. Formulations to make

methylvinyl, $M_n = 69,000$, and $M_w = 125,000$; and for 100% methylvinyl copolymer, $M_n = 103,500$ and $M_w = 199,000$.^{6,80} The TGA onset temperature in air and weight-percent remaining after 737°C were: 5% methylvinyl copolymer, 370°C, 46%; 7.5% methylvinyl, 375°C and 49.5%; for 100% methylvinyl, 420°C, 58.5%. For TGA tests in nitrogen, the onset temperature, the temperature at which further degradation ceases, and the weight-percent residue were: 5% methylvinyl, 360 and 670°C and 41%; for 7.5% methylvinyl, 420 and 680°C and 51%; for 100% methylvinyl, 450 and 690°C and 75%. After degradation in air, the residue consisted of SiO_2 , but the residue after decomposition in nitrogen was an intractable black substance essentially stripped of hydrogen, but otherwise containing a similar composition of silicon, carbon, and oxygen, compared to the starting material.^{6,84,85}

Mass spectra were obtained from the pyrolysis products of a 1% methylvinyl-99% dimethylsiloxane copolymer, and a 100% vinylmethylsiloxane copolymer. It was concluded not only that the methylvinyl copolymer was more thermally stable than the dimethylsiloxane copolymer, but also that there was less silicon in the degradation products of the latter.^{81,82}

The copolymers containing 5% methylvinyl/95% dimethylsiloxane, 7.5% methylvinyl/92.5% dimethylsiloxane, and 100% methylvinylsiloxane were cured with dicumyl peroxide, and a hydrophobic silica was added as filler. Either Fe_2O_3 or $\text{Fe}(\text{CO})_5$ were added as antioxidants. Tensile strength, elongation, stress-relaxation, heat aging, and other properties were determined. The T_g for the cured elastomer was very close to the T_g for the uncured materials.⁸⁶

A number of polymer samples were prepared from the bis-silanol and methylvinylchlorosilane or its mixtures with dimethyldichlorosilane (so that the bis-silanol and the mixed dichlorosilane had 1:1 mole ratio) in ether or in THF solvent; M_w values above 100,000 were obtained in many cases. It was found that T_g was -76°C for 100% methylvinyl copolymer and -69°C for 98% dimethyl/2% methylvinylsiloxane copolymer; these polymers were cured with dicumyl peroxide, with hydrophobic silica filler, and 3 phr ferric oxide; mechanical properties were given.⁵ Other copolymers were made from these reactants in THF solvent at 25°C, with nitrogen flowing through to remove HCl product. For the copolymer of 99% dimethyl/1% methylvinylsiloxane, the T_g was -65°C, the M_w was 27,000, and the ^1H NMR was presented. The TGA data indicated an onset of thermal degradation (subsequently referred to as "onset") at 420°C and end of degradation at 670°C, with 33% residue. For the copolymer of 99% dimethyl and 3% methylvinylsiloxane, the T_g was -69°C, and the M_w was 28,000; the ^1H NMR was presented. For the 100% methylvinylsiloxane polymer, the M_w was 97,000, the T_g was -76°C, and the ^1H and ^{13}C NMR were presented.⁸⁷

Tetramethyldisiloxane Copolymer. The alternating tetramethyldisiloxane copolymer was prepared from the reaction of the bis-silanol with decamethyl-1,5-diaza-3,7-dioxo-2,4,6,8-tetrasilacyclooctane, at 160°C for 8 hours. The IR was

The homopolymer is not elastomeric; it is a strong fiber-forming polymer; it is more stable to thermal and oxidative degradation than polydimethylsiloxane in the temperature range 200-305°C. The relationship between the weight-average molecular weight (M_w) and intrinsic viscosity (η) was expressed by the equation: $\eta = 1.12 \times 10^{-4} M_w^{0.75}$.² The glass transition temperature (T_g) was -25°C.⁷⁷ The IR of this homopolymer was described;²⁷ other properties were presented.⁷⁸

Dimethylsiloxane Copolymer. A method for preparing a very high molecular weight alternating copolymer of the bis-silanol and dimethylsiloxane was from the condensation of the disilanol with bis(1,1-tetramethylene-3-phenylureido(dimethylsilane)).⁷⁹ For molecular weights exceeding 100,000 the reaction was monitored by either H^1 NMR or by gel permeation chromatography (GPC). The IR, H^1 NMR, and the C^{13} NMR of this polymer were presented. The number-average molecular weight (M_n) was 71,500 and the M_w was 132,000 by GPC for this polymer.⁸⁰ T_g was -62°C for this very viscous polymer. The onset of thermal degradation as determined by thermogravimetric analysis (TGA) was 345°C in air and 400°C in nitrogen; there was 39.5% residue at temperatures above 735°C. The degradation products from the pyrolysis were identified.^{81,82} The intrinsic viscosity versus molecular weight relationship in THF was given as $\eta = 7.86 \times 10^{-5} M_w^{0.75}$.^{7,6}

This polymer was also prepared from the reaction of the bis-silanol and bis(dimethylamino)dimethylsilane in toluene under reflux conditions. Polymer with intrinsic viscosity 0.98 dl/g in THF was obtained. Polymer was prepared of intrinsic viscosity (in THF) of 0.71 by the reaction of the disilanol with bis(acetoxy)dimethylsilane in refluxing toluene,⁸³ or by the reaction of bis-silanol and dimethyldichlorosilane; M_w above 100,000 were obtained.⁵ The temperature corresponding to 10% weight loss by TGA was 440°C. In an isothermal TGA test at 316°C, the polymer lost 5% in 2 hours and 31% in 11 hours.⁷⁷ Upon completion of the TGA decomposition in air, the residue was found to consist of SiO_2 . However, upon completion of this test in nitrogen, the residue was found to be an intractable Si-O-C material. During pyrolysis in helium, volatile products began to be emitted around 400°C, with maximum gas evolution around 500°C. Further volatiles were not evolved above 630°C.⁶

Films were prepared from toluene solution, adding partially hydrolyzed ethyl silicate and dibutyltin diacetate, with or without colloidal silica. Elastomers of ultimate tensile strength 16,000 psi and elongation 1130% were obtained.⁷⁷

Copolymer with Dimethylsiloxane and Methylvinylsiloxane. Polymers were prepared with a 1:1 mole ratio of *p*-bis(dimethylhydroxysilyl)benzene and with a mixture of bis(1,1-tetramethylene-3-phenylureido)methylvinylsilane and -dimethylsilane. For copolymers containing 95% dimethyl- and 5% methylvinylsiloxane and for copolymers containing 92.5% dimethyl- and 7.5% vinylmethyl, and for polymer containing 100% vinylmethylsiloxane, the H^1 NMR, the IR, the C^{13} NMR were presented and discussed. After reprecipitation from THF into methanol, the molecular weights were: 5% methylvinylsiloxane, $M_n = 67,000$, $M_w = 119,000$; for 7.5%

1,4-Disila-2,5-Cyclohexadiene Derivatives

These compounds can be considered similar to the bis(silyl)arylenes in that such compounds would constitute a bulky disilyl group if homopolymerized or copolymerized with other groups, such as siloxanes.

Hexachlorodisilane reacts with acetylene at 450-550°C in a quartz tube to produce 1,1,4,4-tetrachloro-1,4-disila-2,5-cyclohexadiene in a 30% yield.^{69,70} The reaction between 1,1,2,2-tetramethoxy-1,2-dimethyldisilane with acetylene at 400°C produced 1,4-dimethoxy-1,4-dimethyl-1,4-disila-2,5-cyclohexadiene in a 60% yield; this is a liquid, with a boiling point of 100°C/40mm; the H¹ NMR and the IR were described.⁷¹

1,1,2,2-Tetramethoxy-1,2-dimethyldisilane reacted with dimethyl-acetylene to produce 1,4-dimethoxy-1,2,3,4,5,6-hexamethyl-1,4-disila-2,5-cyclohexadiene;^{72,73} and the reaction between 1,1,2,2-tetramethoxy-1,2-dimethyldisilane and 1,2-diphenylacetylene produced 1,2,5,6-tetraphenyl-1,4-disila-2,5-hexadiene.⁷²

OTHER DERIVATIVES

Bis(chloro-*t*-butyl)benzene (the preparation is described) reacted, in THF solvent, with magnesium and dimethylchlorosilane to form bis(dimethylsilyl-*t*-butyl)benzene. The diethoxy analog was made. By NaOH hydrolysis, *p*-bis(1,1-dimethyl-2-dimethylhydroxysilyl)ethyl benzene was made. This was polymerized in the presence of KOH.⁷⁴

Benzylphenyltrichlorosilane reacted with trichlorosilane, 300°C, in the presence of BCl₃ to produce a 17% yield of bis(trichlorosilylphenyl)methane, and benzyltrichlorosilane reacted with trichlorosilane in the presence of BCl₃ at 300°C to form a 16% yield of (trichlorosilyl)trichlorosilylmethylbenzene; trimethylphenylsilane reacted with trichlorosilane under the same reaction conditions to form a 37.7% yield of a mixture of compounds of formula ((CH₃)_nCl_{3-n}Si)₂C₆H₄.⁷⁵

POLY(ARYLENE-SILOXANES)

p-BIS(SILYL)BENZENE) DERIVATIVES

p-Bis(dimethylhydroxysilyl)benzene Polymers

Homopolymers. Bis(dimethylhydroxysilyl)benzene was homopolymerized, using as catalyst *n*-hexylamine-2-ethylhexanoate,² or by heating the disilanol with 0.02% NaOH in N₂ to 250°C for 47.5 hours.¹⁵ Tetracyanoethylene is an excellent catalyst, effectively homopolymerizing the disilanol.⁷⁶

NAPHTHALENE AND ANTHRACENE DERIVATIVES

The Grignard preparation in THF of 1,4-bis(dimethylhydrogensilyl)naphthalene was described. This was converted to the corresponding bis-silanol by ethanolysis, followed by NaOH hydrolysis. Some physical properties were listed.⁸ The reaction between 2,7-dibromo-naphthalene, dimethyldichlorosilane, and magnesium in ether produced 2,7-bis(dimethylchlorosilyl)naphthalene and polymeric materials.⁶¹

9,10-Dilithio-9,10-dihydroanthracene reacted with dimethylchlorosilane to produce a 59% yield of 9,10-bis(dimethylsilyl)-9,10-dihydroanthracene.⁶²

Naphthalene reacted (BCl₃ catalyst, 300°C) with an excess of trichlorosilane to produce bis(trichlorosilyl)naphthalene (in a yield of 16%) and hydrogenated naphthalene derivatives. When this reaction was conducted with methyldichlorosilane, the products consisted of around 10% bis(methyldichlorosilyl)naphthalene, along with hydrogenated naphthalene derivatives.⁶³

1,4-Dimethylnaphthalenes and 1,5-dimethylnaphthalenes were heated with trichlorosilane at 660°C and produced 1,1-dichloro-5- and -6-methyl-1-silaacenaphthenes in approximately 30% yield. If these products were passed through the tube with trichlorosilane, then tetrachloro-1,5- and 1,6-disilapyracenes were formed in a yield of 85%.⁶⁴ The pyrolysis of dichloro-1-naphthylsilane under these conditions produced 1,1,2,2-tetrachloro-1,2-disilaacenaphthene, along with 1,2-dichloro-1,2:1,2-di-1,8-naphthalenedisilane.⁶⁵ 2-Biphenyl trichlorosilane and trichlorosilane reacted under these conditions to produce 9,9-dichloro-4-trichlorosilyl-9-silafluorene in a yield of 15%.⁶⁶

In a direct synthesis reaction, passing dichlorophenyl-*o*-chlorophenylsilane over a contact mass containing 25% copper, 4% CdCl₂, 3% Co₃O₄, and 68% silicon at 540°C resulted in a yield as high as 60% of 9,9,10,10-tetrachloro-9,10-dihydro-9,10-disilaanthracene.⁶⁷ In an extension of this effort, it was found that *o*-dichlorobenzene reacted with a contact mass of silicon, copper, and small amounts of zinc, cadmium, and cobalt compounds to produce 9,9,10,10-tetrachloro-9,10-dihydro-9,10-disilaanthracene.⁶⁸

DURYLENE DERIVATIVES

The Grignard preparation in THF of bis(dimethylhydrogensilyl)durylene was described. This was converted to the corresponding bis-silanol by ethanolysis, followed by NaOH hydrolysis. Some physical properties were listed.⁸

temperature from TGA corresponding to 10% weight loss was 350°C. For polydiphenylsilmethylene (mp=340°C), the temperature from TGA corresponding to 10% weight loss was 390°C.¹⁰⁷

A low-molecular weight sample of polydimethylsilmethylene, when pyrolyzed to 585°C, left only 1% residue, and was not regarded as an effective SiC precursor.¹⁵⁴ In another study, TGA results indicated that one high-molecular-weight sample left a 10% residue at 670°C and another sample left a 5% residue at 660°C.¹²⁶ However, the thermal decomposition of polydimethylsilane produced polymethylsilmethylene, $(\text{SiH}(\text{CH}_3)\text{CH}_2)_n$; this decomposed upon further heating to form SiC.^{155,156,157,158,159}

CONCLUSIONS

Of the various types of thermally stable elastomers, two types are worth further investigation: silarylene-siloxane polymers and polysilmethylenes. The silarylene-siloxane polymers and the polysilmethylenes are more thermally stable than the corresponding polysiloxanes.

The preparation and properties of alternating copolymers that were prepared from the condensation polymerization of arylenedisilanol with silanes, disiloxanes, and other silicon compounds were described. The preparation and properties of the known arylenedisilanol have been presented in this report. The bis-silanol were generally prepared by the Grignard addition of halosilane to dihalobenzene, a process that would be expensive if conducted in a large-scale operation. In this report, reactions are described that may potentially yield a bis-silanol at reasonable cost. For example, the reaction of 1,2-dichlorotetramethyldisilane with *p*-dichlorobenzene reportedly yielded *p*-bis(chlorodimethylsilyl)benzene. Likewise, the reaction of 1,1,2,2-tetramethoxydimethyldisilane with acetylene to form 1,4-dimethoxy-1,4-dimethyl-1,4-disila-2,5-cyclohexadiene is worth examining. It should be possible to hydrolyze this to the bis-silanol and produce alternating copolymers, via condensation, that are thermally stable. Hence, there are several possible approaches to the cost-effective preparation of thermally stable silarylene-siloxane polymers.

There is a substantial literature regarding polysilmethylenes, generally prepared by the ring-opening polymerization of 1,3-disilacyclobutanes to produce the polymer; discussed most frequently is polydimethylsilmethylene, prepared from 1,1,3,3-tetramethyl-1,3-disilacyclobutane. A Grignard method was used for the preparation of the disilacyclobutane, although it can also be made by the thermolysis of 1,1-dimethyl-1-silabutane. Polydimethylsilmethylene is quite thermally stable, although it did not yield SiC upon thermal decomposition.

REFERENCES

1. Naval Weapons Center. *Thermally Stable Elastomers: A Review*, by Robert A. Rhein. China Lake, Calif., NWC, October 1983. (NWC TP 6372, publication UNCLASSIFIED.)
2. R. L. Merker, and M. J. Scott. "Preparation and Properties of Poly(tetramethyl-*p*-silphenylene-siloxane)." *J. Polymer Sci., Pt. A.*, Vol. 2, No. 1 (1964), pp. 15-29.
3. Dow Corning Corporation. Silarylenesilanes, Silanols, and Polysiloxanes. 23 January 1963. (British Patent 916,135.)
4. C. U. Pittman. "Oxysilane Polymers From Silanediol-bis(dimethylaminosilane) Polycondensations, Synthesis and Properties." *J. Polymer Sci.*, Vol. 14 (1976), pp. 1715-1734.
5. M. J. C. Gomez. "Bench Scale Production and Mechanical Evaluation of Exactly Alternating Silarylene-siloxane Polymers." M. S. Thesis, University of Massachusetts, 1982.
6. P. R. Dvornic. "Preparation and Evaluation of Exactly Alternating Silarylene-siloxane Polymers." Ph.D. Thesis, University of Massachusetts, 1979.
7. L. D. Akhavoza and others. Bis(dimethylsilyl)benzene. 26 August 1969. (U.S.S.R. Patent 218.887.)
8. H. N. Beck and R. G. Chaffee. "Arylene Silicon Compounds." *Chemical Engineering Data*, Vol. 8, No. 4 (1963), pp. 602-603.
9. V. Bazant and M. Cerny. "Organosilicon Compounds. CXV. Synthesis of *p*-Bis(Silylarylene) Compounds by the Grignard Reaction of *p*-Dichlorobenzene With Dialkoxy-, Dichloro-, Alkoxychloro-, and Chlorodiphenylsilanes." *Collect. Czech. Chem. Commun.*, Vol. 39, No. 7 (1974), pp. 1728-1734.
10. V. Bazant and M. Cerny. "Organosilicon Compounds. CXVI. Synthesis of *p*-Bis(Silylarylene) Compounds by the Grignard Reaction of *p*-Dibromobenzene With Dialkoxy-, Alkoxychloro-, and Chlorodiphenylsilanes." *Collect. Czech. Chem. Commun.*, Vol. 39, No. 7 (1974), pp. 1735-1739.
11. V. Bazant and M. Cerny. "Organosilicon Compounds. CXVI. Synthesis of *p*-Chlorophenyl-diphenylsilanes and Unsymmetrical *p*-Disilylarylenes From *p*-Dichlorobenzene and *p*-Bromochlorobenzene." *Collect. Czech. Chem. Commun.*, Vol. 39, No. 7 (1974), pp. 1880-1884.
12. L. W. Breed and others. *Synthesis and Evaluation of New High Polymers for Coating Applications* 1965, 112 pp. (NASA-CR-64448, NASA Accession No. N65-32078, publication UNCLASSIFIED.)

NWC TP 6499

13. J. G. Noltes and G. J. M. van der Kerk. "Studies in IVth Group Organometallic Chemistry. IX. Synthesis of Organosilicon Compounds and Polymers Containing the *p*-Phenylene Group." *Rec. Trav. Chim.*, Vol. 81. (1962), pp. 565-577.
14. M. Sveda. Disilahydrocarbons. 24 July 1951. (U.S. Patent 2,561,429.)
15. M. Sveda. Linear Polyarylene Siloxanes. 24 July 1951. (U.S. Patent 2,562, 000.)
16. G. M. Omietanski. Disilylarylenes. 11 September 1962. (U.S. Patent 3,053,872.)
17. K. A. Andrianov. "Catalytic Polycondensation of *p*-Bis(dimethylhydroxysilyl)benzene With Diphenyldihydroxysilane and Octamethylcyclotetrasiloxane." *Vysokomol. Soedin.*, Vol. 8, No. 9. (1966), pp. 1618-1622.
18. M. A. Shippey and P. B. Dervan. "Trimethylsilyl Anions: Direct Synthesis of Trimethylsilylbenzenes." *J. Org. Chem.*, Vol. 42, No. 15. (1977), pp. 2654-2655.
19. M. Matsumoto. Organosilicon Compounds. 19 September 1977. (Japanese Patent 77,111,549.)
20. Y. Nagai and M. Matsumoto. Halophenylsilanes and Phenylenedisilanes. 29 September 1977. (Japanese Patent 77,116,442.)
21. H. Matsumoto and others. "Synthesis of *p*-Bis(dimethylhydroxysilyl)benzene." *Org. Prep. Proced. Int.*, Vol. 13, No. 2 (1981), pp 118-123.
22. B. I. Vainshtein and L. P. Bogovtseva. "Radiation-Chemical Vapor-Phase Synthesis of Bis(organochlorosilyl) Derivatives of Aromatic Hydrocarbons." *Zh. Obshch. Khim.*, Vol. 46, No. 4. (1976), pp. 852-855.
23. G. S. Popeleva and others. "Reaction of Methyl(chlorophenyl)chlorosilanes With Hydrochlorosilanes." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 3. (1966), pp. 478-482.
24. G. S. Popeleva and others. "Reaction of Halogen Derivatives of Arylchlorosilanes With Chlorosilane Hydrides." *Zh. Obshch. Khim.*, Vol. 32. (1962) pp. 557-562.
25. R. E. Burks, Jr. and others. "Copolymers and Elastomers With Alternating Dioxysilphenylene and Silane Units." *J. Polymer Sci., Polym. Chem. Ed.*, Vol. 22, No. 2 (1973), pp. 319-326.
26. V. E. Nikitenkov. "Synthesis of 1,4-Bis(dimethylhydroxysilyl)benzene and its Conversion Into Cyclic Compounds." *Zh. Obshch. Khim.*, Vol. 35, No. 9 (1965), pp. 1666-1669.
27. B. Lengyel and others. "Infrared Spectroscopic Study of *p*-Bis(dimethylhydroxysilyl)benzene and of Poly(tetramethyl-*p*-silphenylene-siloxane)." *Acta Chim.*, (Budapest), Vol. 80, No. 3 (1974), pp. 287-296.
28. B. A. Bluestein and E. R. Evans. Aromatic Silicon Compounds 18 January 1979. (German Patent 2,828,518.)
29. L. W. Breed and others. *New Synthetic Methods for Silicon-Nitrogen Polymers*. Midwest Research Institute, Kansas City, MO, 1969. (AFML TR-69-20-pt-4, publication UNCLASSIFIED.)

NWC TP 6499

30. R. W. La Rochelle and T. D. Mitchell. Silarylenesilane diol. 22 June 1976. (U.S. Patent 3,965,134.)
31. G. M. Ometanski. Random Siloxane Copolymers. 22 November 1966. (U.S. Patent 3,287,310.)
32. B. Zelei and others. "Vibrational Spectra and IR Dichroism of *p*-Bis(dimethylhydroxysilyl) benzene." *Spectrochim. Acta*, Part A, Vol. 34A, No. 3 (1978), pp. 343-352.
33. L. W. Breed and R. L. Elliott. "Arylendisilanols." *J. Organometal. Chem.*, Vol. 9, No. 1 (1967), pp. 188-192.
34. L. W. Breed and others. "Arylene-Modified Siloxanes." *J. Polymer Sci.*, Part A-1, Vol. 5 No. 11 (1967), pp. 2745-2755.
35. Dow Corning Corporation. *FASIL Integral Fuel Tank Sealants. Part I*, by O. R. Pierce and others. Midland, MI., May 1980. (AFML TR-79-4009-pt-II, publication UNCLASSIFIED.)
36. Dow Corning Corporation. *Hybrid Fluorosilicones for Aircraft Fuel Tank Sealants. Synthesis of Fluorocarbon and Fluorocarbon Ether Hybrid Fluorosilicone Polymers*, by O. R. Pierce and others. Midland, MI., February 1973. (AFML TR-70-278-pt-III, AD-912135L, publication UNCLASSIFIED.)
37. H. Rosenberg and E. W. Choe. "Synthesis and Properties of Fluoroalkylarylene Siloxanylene (FASIL) High-Temperature Polymer." *ACS Symp.*, Ser. No. 132 (1980), pp. 47-55.
38. L. Ya Karpov. Organochlorosilanes. 22 October 1965. (French Patent 1,415,110.)
39. L. Ya. Karpov. Arylchlorosilanes. 19 January 1967. (German Patent 1,232,579.)
40. A. J. Barry and others. Organohalosilanes. 12 April 1950. (British Patent 635,645.)
41. L. De Pree and others. Chlorosilyl Benzenes. 25 December 1951. (U.S. Patent 2,580,159.)
42. A. D. Petrov and others. "Reaction of Silicon Hydrides With α - and β -Chloronaphthalenes and *p*-Dichlorobenzene. Pyrolysis of Ethylchlorosilanes in the Presence of Aryl Chlorides." *Kokl. Akad. Nauk SSSR*, Vol. 132 (1960), pp. 1099-1102.
43. M. F. Shostakovskii and others. "High Temperature Condensation of Hydrochlorosilanes With Chloroarylfluoro- and Chloroarylchlorosilanes." *Zh. Obshch. Khim.*, Vol. 34, No. 8 (1964), pp. 2620-2622.
44. K. A. Andrianov and V. M. Kotov. "Disproportionation Reaction of Diphenyldichlorosilane." *Dokl. Akad. Nauk SSSR*, Vol. 167, No. 4 (1966), pp. 811-814.
45. K. A. Andrianov and V. M. Kotov. "Pyrolysis of Phenyltrichlorosilane." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 6 (1969), pp. 1265-1268.
46. J. B. Rust. Polysilyl Derivatives. 21 September 1954. (U.S. Patent 2,689,860.)
47. A. J. Barry. Phenylene-Linked Organopolysilanes. 26 June 1951. (U.S. Patent 2,557,931.)

48. A. J. Barry and others. "Direct Process for Preparation of Arylhalosilanes." *Advances in Chem., Ser.* Vol. 23 (1959), pp. 246-264.
49. A. J. Barry and others. "Arylhalosilanes." *Ind. Eng. Chem.*, Vol. 51 (1959), pp. 131-138.
50. Dow Corning Corporation. Silicone Resins. 16 January 1963. (British Patent 915,931.)
51. A. F. Gordon. Phenyltrichlorosilane. 17 July 1956. (U.S. Patent 2,755,295.)
52. A. J. Barry. Arylhalosilanes. 20 January 1953. (U.S. Patent 2,626,266.)
53. E. A. Chernyshev and E. V. Vangnits. "Reaction of Silicon Hydrides With Aromatic Compounds in Liquid Phase in the Presence of Boron Trichloride." *Zh. Obshch. Khim.*, Vol. 32 (1962), pp. 24-29.
54. H. A. Clark. Phenylchlorosilanes. 19 June 1951. 198a-5. (U.S. Patent 2,557,782.)
55. A. J. Barry. Chloroaromatic Chlorosilanes. 7 May 1952. (British Patent 671,710.)
56. Air Force Materials Laboratory. *Arylenesiloxane Polymers for Use as High Temperature Aircraft Integral Fuel Tank Sealants. Part I. The Synthesis and Reactions of Novel Linear and Cyclic Alkarylsiloxanes*, by E. W. Choe and H. Rosenberg, Wright-Patterson AFB, Ohio. December 1976. (AFML TR-75-182, Part I AD B032562, publication UNCLASSIFIED.)
57. J. Dunogues and others. "Double Friedel-Crafts Reaction Between Chloromethyl Trichlorosilane and Benzene. Practical Synthesis of *p*-Bis(trimethylsilylmethyl)benzene." *Bull. Soc. Chim. Fr.*, Nos. 11-12, Pt. 2 (1976), pp. 1933-1934.
58. N. C. Holdstock. Unsymmetrical Poly(arylenesiloxane) Fluids. 7 January 1964. (U.S. Patent 3,117,149.)
59. A. A. A. El-Attar and M. Cerny. "Preparation and Thermal Behavior of Some Polyarylsilanes." *Collect. Czech. Chem. Commun.*, Vol. 40, No. 9 (1975), pp. 2806-2815.
60. G. Baum. "Aromatic Organosilicon Compounds." *J. Org. Chem.*, Vol. 23 (1958), pp. 480-481.
61. P. F. Silva and N. G. Holdstock. Bis(diorganohalosilyl) Aromatic Hydrocarbons. 4 December 1962. (U.S. Patent 3,067,230.)
62. I. M. Gverdsiteli and others. "Synthesis of Unsaturated Organosilicon Compounds Based on 9,10-bis(dimethylsilyl)-9,10-dihydroanthracene." *Zh. Obshch. Khim.*, Vol. 42, No. 9 (1972), pp. 2022-2024.
63. E. A. Chernyshev and others. "Catalytic Reaction of Chlorosilanes With Naphthalene in Liquid Phase." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 10 (1966), pp. 1817-1820.
64. E. A. Chernyshev and S. A. Shepinov. "Organosilicon Heterocyclic Compounds. V. Synthesis of 1,5- and 1,6-Disilopyracenes." *Zh. Obshch. Khim.*, Vol. 40, No. 8 (1970), pp. 1744-1746.

65. E. A. Chernyshev and others. "Silicon-Containing Heterocyclic Compounds. XX. Participation of Organochlorosilylenes in Pyrolytic Formation of Silicon-Containing Heterocycles." *Zh. Obshch. Khim.*, Vol. 45, No. 10 (1975), pp. 2223-2226.
66. E. A. Chernyshev and others. "Organosilicon Heterocyclic Compounds. XIX. Organosilicon Derivatives of 9,9-Dichloro-9-silafluorene." *Zh. Obshch. Khim.*, Vol. 45, No. 11 (1975), pp. 2464-2465.
67. E. A. Chernyshev and others. "Silicon-Containing Heterocyclic Compounds. XXXVI. Synthesis of 9,9,10,10-Tetrachloro-9,10-disila-9,10-dihydroanthracene and 9,9-Dichloro-9-silafluorene From *o*-Chlorophenyl Phenylchlorosilane." *Zh. Obshch. Khim.*, Vol. 50, No. 7 (1980), pp. 1573-1576.
68. E. A. Chernyshev and others. "Silicon-Containing Heterocyclic Compounds. XXXVII. Direct Synthesis of 9,9,10,10-Tetrachloro-9,10-disila-9,10-dihydroanthracene From *o*-Dichlorobenzene." *Zh. Obshch. Khim.*, Vol. 50, No. 8 (1980), pp. 1790-1793.
69. E. A. Chernyshev and others. "Formation of 1,1,4,4-Tetrachloro-1,4-disilacyclo-2,5-Hexadiene During Pyrolysis of Hexachlorodisilane and Octachlorotrisilane in the Presence of Acetylene." *Zh. Obshch. Khim.*, Vol. 41, No. 5 (1971), pp. 1175-1176.
70. E. A. Chernyshev and others. "Silicon-Containing Heterocyclic Compounds. XXX. Thermal Reactions of Dichlorosilylene With Unsaturated Compounds." *Zh. Obshch. Khim.*, Vol. 48, No. 4 (1978), pp. 830-838.
71. W. H. Atwell. 1,4-Disilacyclohexa-2,5-dienes. 16 September 1971. (German Patent 1,768,896.)
72. Dow Corning Corporation. Disilacyclohexadienes. 6 August 1969. (British Patent 1,160,661.)
73. W. H. Atwell and D. R. Weyenberg. "Silylene Chemistry." *Intra-Sci. Chem. Rep.*, Vol. 7, No. 4 (1973), pp. 137-145.
74. R. D. Spencer. Organosilicon Compounds and Polymers and Copolymers Therefrom. 14 February 1967. (U.S. Patent 3,304,320.)
75. E. A. Chernyshev and others. "Synthesis of Bis(organochlorosilyl) Derivatives of Aromatic Hydrocarbons and Tris(trichlorosilyl)benzene." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 10 (1964), pp. 1807-1814.
76. R. H. Banev. Silanol Condensation Using Tetracyanoethylene as a Catalyst. 14 February 1967. (U.S. Patent 3,304,271.)
77. R. F. Burks, Jr. and others. Copolymers and Elastomers With Alternating Dioxysilphenylene and Silane Units." *J. Polymer Sci., Polym. Chem. Ed.*, Vol. 11, No. 2 (1973), pp. 319-326.
78. W. R. Dannavatt. "Silylene and Silylene-siloxane Polymers." *Inorg. Macromol. Rev.*, Vol. 1, No. 3 (1971), pp. 165-189.
79. P. R. Dvornic and R. W. Lenz. "Exactly Alternating Silylene-siloxane Polymers. I. The Synthesis and Stability of Bis(1,1-tetramethylene-3-phenylureido)dimethylsilane." *J. Appl. Polymer Sci.*, Vol. 25 (1980), pp. 641-652.

NWC TP 6499

80. P. R. Dvornic and R. W. Lenz. "Exactly Alternating Silarylene-siloxane Polymers. II. The Condensation Polymerization of Arylenedisilanol and Bisureidosilanes." *J. Polymer Sci., Polym. Chem. Ed.*, Vol. 20, No. 4 (1982), pp. 951-966.
81. G. D. Riska. "Thermal Analysis and Analytical Properties of Phosphazene and Silarylene-siloxane Copolymers." PhD. Thesis, University of Massachusetts, 1983.
82. A. Ballistreri and others. "Mass Spectral Characterization and Thermal Decomposition Mechanism of Alternating Silarylene-siloxane Polymers." University of Massachusetts, unpublished manuscript in process.
83. H. Rosenberg and B. D. Nahlvski. "Synthesis of Poly(arylenesiloxanylenes) by Silanol-Acetoxy-silane Condensation." *Polymer Prepr., Am. Chem. Soc., Div. Chem.*, Vol. 19, No. 2 (1978), pp. 625-630.
84. R. W. Lenz and P. R. Dvornic. *Preparation and Evaluation of Exactly Alternating Silarylene-siloxane Elastomers*. University of Massachusetts, Amherst, MA, 1978. Annual Report No. 2, Contract N00014-76-C-0700, 33 pp. (Publication UNCLASSIFIED.)
85. P. R. Dvornic and R. W. Lenz. "Exactly Alternating Silarylene-siloxane Polymers. VI. The Thermal Stability and Degradation Behavior." *Polymer*, Vol. 24 (1983), pp. 763-768.
86. M. E. Livingston and others. "Exactly Alternating Silarylene-siloxane Polymers. V. Evaluation of the Mechanical Properties of Crosslinked Elastomers." *J. Appl. Polym. Sci.*, Vol. 27, No. 9 (1982), pp. 3239-3251.
87. Y. C. Loi and others. "Exactly Alternating Silarylene-siloxane Polymers. IV. Step-Growth Polymerization Reactions With Dichlorosilane Monomers." *J. Polymer Sci., Polym. Chem. Ed.*, Vol. 20 (1982), pp. 2277-2288.
88. T. C. Wu. Method for Making Organosilicon Copolymers. 13 June 1967. (U.S. Patent 3,325,530.)
89. Dow Corning Corporation. *FASIL Integral Fuel Tank Sealants, Part I*, by O. R. Pierce and others. Midland, MI, January 1979. (AFML TR-79-4009-pt-I, publication UNCLASSIFIED.)
90. Dow Corning Corporation. *FASIL Integral Fuel Tank Sealants, Part III*, by O. R. Pierce and others. Midland, MI. (AFML TR-79-4009-pt-III, publication UNCLASSIFIED.)
91. L. W. Breed and J. C. Wiley, Jr. Vinyl-Substituted Siloxane Siloxazane Polymers. 9 April 1974. (U.S. Patent 3,803,086.)
92. L. W. Breed and R. L. Elhott. Ordered Poly(Arylenesiloxane) Polymers for Coatings and Elastomers. 13 May 1969. (U.S. Patent 3,444,127.)
93. Air Force Materials Laboratory. *Arylenesiloxane Polymers for Use as High Temperature Aircraft Integral Fuel Tank Sealants, Part II. Synthesis and Properties of Alkyl- and Fluoro-alkyl-Substituted Alkarylsiloxane Polymers*, by E. W. Choe and H. Rosenberg. Wright-Patterson AFB, Ohio, December 1977. (AFML-TR-675-182, Part II, AD B047114, publication UNCLASSIFIED.)

94. I. J. Goldfarb and others. "Thermal Stability-structure Correlations in Arylenesiloxanylene Polymers." *Organomet. Poly.*, (Symp.), pp. 239-255. New York Academic Press, N.Y., 1978.
95. H. Rosenberg and E. W. Choe. "Methyl- and 3,3,3-Trifluoropropyl-Substituted *m*-Xylylene-siloxanylene Polymers." *Organomet. Poly.*, (Symp.), pp. 239-247. New York Academic Press, N.Y., 1978.
96. General Electric Company. Organosilicon Compounds and Elastic Polymers Therefrom. 7 June 1961. (British Patent 870,024.)
97. C. A. Pearce and others. Heat-Resistant Organosilicon Polymers. 16 May 1962. (British Patent 896,301.)
98. J. H. Ko and J. E. Mark. "Configuration-Dependent Properties of Polydimethylsilylmethylene Chains. I. Experimental Results." *Macromolecules*, Vol. 8, No. 6 (1975), pp. 869-874.
99. W. A. Kriner. "The Preparation of Cyclic Siliconmethylene Compounds." *J. Org. Chem.*, Vol. 29, No. 6 (1964), pp. 1601-1606.
100. W. A. Kriner. Heterocyclic and Linear Silicon Methylene and Polysiloxane Compounds Containing Silicon Methylene Units. 13 April 1965. (U.S. Patent 3,178,392.)
101. H. Gilman and W. H. Atwell. "Preparation of 1,1,3,3-Tetramethyl-1,3-disilacyclobutane." *J. Org. Chem.*, Vol. 2, No. 3 (1964), pp. 277-278.
102. G. Greber and G. Degler. "Oligomeric Silicon Compounds With Functional Groups. VI. Preparation of Homologous Ω , Ω' -dichloropolysilylmethylenes." *Makromol. Chem.*, Vol. 52, (1962), pp. 174-183.
103. W. H. Knoth, Jr. and R. V. Lindsey, Jr. "1,1,3,3-Tetramethyl-1,3-disilacyclobutane." *J. Org. Chem.*, Vol. 23, (1958), pp. 1392-1393.
104. W. H. Knoth, Jr. Organosilicon Compounds. 2 September 1958. (U.S. Patent 2,850,514.)
105. G. Fritz. "Formation and Properties of Carbosilanes." *Agnew. Chem. Int. Ed. Engl.*, Vol. 6, No. 8 (1967), pp. 677-683.
106. N. S. Nametkin and others. "Synthesis of 1,1,3,3-Tetrasubstituted-1,3-Disilacyclobutanes." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 5 (1965), pp. 929-930.
107. N. S. Nametkin and others. "1,3-Disilacyclobutanes and Their Polymers." *Dokl. Akad. Nauk SSSR*, Vol. 170, No. 5 (1966), pp. 1088-1091.
108. G. Levin. Fluorine-Containing Disilacyclobutanes and Their Polymers. 29 August 1969. (French Patent 1,579,767.)
109. N. Auner and J. Grobe. "Silaethenes. II. Preparation and Characterization of 1,3-Disilacyclobutanes." *J. Org. Chem.*, Vol. 45, No. 2 (1980), pp. 151-177.

110. N. S. Nametkin and others. "Formation of 1,3-Disilacyclobutanes in Reaction of Pyrolytic Condensation of 1-Silacyclobutanes." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 3 (1966), pp. 584-585.
111. N. S. Nametkin and V. M. Vdovin. "Reactions of Silacyclobutanes Proceeding With Ring Opening." *Izv. Akad. Nauk SSSR, Ser. Khim.*, No. 5 (1974), pp. 1153-1169.
112. R. D. Bush and others. "Silicon-Carbon Multiple Bonded Intermediates. Evidence for Dipolar Character in Reactions With Trichlorosilane and Other Silicon Halides." *J. Am. Chem. Soc.*, Vol. 96 (1974), pp. 7105-7106.
113. C. M. Golino and others. "Silicon-Carbon Multiple Bonded Intermediates. I. Reactions of Ketones and Aldehydes With Intermediates From Thermolysis of Silacyclobutanes." *J. Org. Chem.*, Vol. 66 (1974), pp. 29-41.
114. J. W. Curry and G. W. Harrison, Jr. "Polymerization and Cyclization of Allyldimethylsilane." *J. Org. Chem.*, Vol. 23 (1958), pp. 1219-1220.
115. J. V. Swisher and H. H. Chen. "Silicon Heterocyclic Compounds. I. Ring Size Effect in Ring Closure by Hydrosilation." *J. Org. Chem.*, Vol. 69, No. 1 (1974), pp. 83-91.
116. R. I. Conlin and P. P. Gaspar. "Evidence for the Dimerization of Dimethylsilylene to Tetramethyldisilene." *J. Am. Chem. Soc.*, Vol. 98, No. 3 (1978), pp. 868-870.
117. G. Fritz and J. Grobe. "Synthesis of Organosilicon Compounds. XVII. The Formation of Silicon-Methylenes in the Pyrolysis of Tetramethylsilane." *Z. Anorg. Allgem. Chem.*, Vol. 315 (1962), pp. 157-174.
118. G. Fritz and others. "Synthesis of Organosilicon Compounds. XVIII. The Constitution of $\text{Si}_2\text{C}_6\text{H}_{16}$ Obtained in the Pyrolysis of Tetramethylsilane." *Z. Anorg. Allgem. Chem.*, Vol. 321 (1963), pp. 10-20.
119. G. Fritz and others. "Carbosilanes." *Advan. Inorg. Chem. Radiochem.*, Vol. 7 (1965), pp. 349-415.
120. P. Potzinger and others. "The Mercury-Sensitized Photolysis of Tetramethylsilane in the Temperature Range 650°K - 800°K. The Heat of Formation of 2-Methyl-2-Silapropene." *Ber. Bunsenges. Phys. Chem.*, Vol. 85 (1981), pp. 1119-1122.
121. E. Bastian and others. "The Direct Photolysis of Tetramethylsilane in the Gas and Liquid Phases." *Ber. Bunsenges. Phys. Chem.*, Vol. 84, No. 1 (1980), pp. 56-62.
122. D. Seyferth and C. J. Attridge. "1,1,3,3-Tetramethyl-1,3-disilacyclobutane and 1,1,3,3-Tetramethyl-1-sila-3-germacyclobutane via Active Metal Derivatives of Bis(chloromethyl)dimethylsilane." *J. Org. Chem.*, Vol. 21, No. 1 (1970), pp. 103-106.
123. P. R. Jones and T. F. O. Lim. "The Addition of Tert-Butyllithium to Vinylhalosilanes. A Novel, High Yield Route to 1,3-Disilacyclobutanes." *J. Am. Chem. Soc.*, Vol. 99, No. 6 (1977), pp. 2013-2015.

NWC TP 6499

124. Dow Corning Corporation. Silacyclobutane Polymers and Telomers. 6 December 1967. (British Patent 1,093,898.)
125. W. A. Kriner. "Catalytic Polymerization of 1,3-Disilacyclobutanes." *J. Polymer Sci.*, Pt. A-1, (1966), pp. 444-446.
126. G. Levin and J. B. Carmichael. "Molecular Weight Distribution and Thermal Characterization of Polydimethylsilmethylene." *J. Polymer Sci.*, Part A-1, Vol. 6, No. 1 (1968), pp. 1-12.
127. W. R. Bamford and others. "Preparation and Properties of Polysilmethylenes: Use of Various Compounds of Group VIII Metals as Catalyst." *J. Chem. Soc.*, Part C, Org., No. 13 (1966), pp. 1137-1140.
128. J. C. Lovie and J. A. C. Watt. Organosilicon Polymers. 23 March 1966. (British Patent 1,023,797.)
129. V. A. Poletaev and others. "Regularities of 1,1,3,3-Tetramethyl-1,3-disilacyclobutane Polymerization on Nickel π -Crotyl Complexes." *Dokl. Akad. Nauk SSSR*, Vol. 208, No. 5 (1973), pp. 1112-1115.
130. V. A. Poletaev and others. "Catalytic Polymerization of Silacyclobutane Monomers in the Presence of Halides of Metals of Variable Valence." *Dokl. Akad. Nauk SSSR*, Vol. 208, No. 5 (1973), pp. 1112-1115.
131. Dow Corning Corporation. Polymerization of Silacyclobutanes. 3 April 1968. (British Patent 1,108,196.)
132. A. V. Topchien. Silmethylene Polymers. 25 February 1966. (French Patent 1,429,781.)
133. N. S. Nametkin and others. "Elastomeric Silmethylene Polymers. 6 October 1966. (German Patent 1,226,310.)
134. N. S. Nametkin and others. "Kinetics of the Thermally Initiated Polymerization of 1,1,3,3-Tetramethyl-1,3-disilacyclobutane." *Dokl. Akad. Nauk SSSR*, Vol. 198, No. 5 (1971), pp. 1096-1098.
135. G. Fritz and N. Geotz. "Formation of Organosilicon Compounds. XXXIV. Low Molecular Weight Carbosilanes From the Pyrolysis of Tetramethylsilane." *Z. Anorg. Allgem. Chem.*, Vol. 375, No. 2 (1970), pp. 171-196.
136. N. S. Nametkin and others. "Polymerization of 1,1,3,3-Tetraphenyl-1,3-disilacyclobutane." *Dokl. Akad. Nauk SSSR*, Vol. 162, No. 4 (1965), pp. 824-826.
137. J. T. Goodwin, Jr. Organo-Silicon Compounds. 10 June 1949. (British Patent 624,551.)
138. G. Greber and G. Degler. Linear Ω , Ω' -Dichloro Organosilane Oligomers. 28 December 1967 (German Patent 1,257,434)
139. J. D. Francis. Silicarbane Polymers. 30 October 1951. (U.S. Patent 2,573,426)

NWC TP 6499

140. Dow Corning Corporation. Organosilicon Polymers. 27 February 1952. (British Patent 667,435.)
141. J. T. Goodwin, Jr. Cyclic Silahydrocarbons. 19 August 1952. (U.S. Patent 2,607,791.)
142. J. T. Goodwin, Jr. Organosilicon Compounds. 10 June 1949. (U.S. Patent 624,550.)
143. J. T. Goodwin, Jr. Polysilumethylene. 4 October 1949. (U.S. Patent 2,483,972.)
144. J. T. Goodwin, Jr. Organosilicon Compounds. 7 November 1949. (British Patent 631,619.)
145. J. T. Goodwin, Jr. Monofunctional Polysilahydrocarbons. 16 May 1950. (U.S. Patent 2,707,512.)
146. J. T. Goodwin, Jr. Silahydrocarbons. 6 March 1951. (U.S. Patent 2,544,079.)
147. H. A. Clark. Organosilicon Polymers. 16 May 1950. (U.S. Patent 2,507,521.)
148. W. I. Patnode and R. W. Schiessler. Halogenated Organosilicon Compounds. 7 August 1945. (U.S. Patent 2,381,000.)
149. N. S. Nametkin and others. "Silumethylene Elastomers." *Vysokomol. Soedin.*, Vol. 7, No. 4 (1965), p 757.
150. J. E. Mark and J. H. Ko. "Configuration-Dependent Properties of Polydimethylsilumethylene Chains. II. Correlation of Theory and Experiment." *Macromolecules*, Vol. 8, No. 6 (1975), pp. 874-878.
151. J. C. Lovie and J. A. C. Watt. Organosilicon Polymers Capable of Being Converted to Elastomers. 7 February 1968. (British Patent 1,102,097.)
152. T. H. Thomas and T. C. Kendrick. "Thermal Analysis of Polysiloxanes. II. Thermal Vacuum Degradation of Polysiloxanes With Different Substituents on Silicon and in the Main Siloxane Chain." *J. Polymer Sci., Part A-2*, Vol. 8, No. 10 (1970), pp. 1823-1830.
153. D. J. Gordon. Substrates for Chromatography. 2 September 1969. (U.S. Patent 3,464,183.)
154. Union Carbide Corporation. *Organosilane Polymers. IV. Polycarbosilane Precursors for Silicon Carbide*, by C. L. Schilling and others. Tarrytown, NY, 1981. (Report 80-1, AD-A099030, publication UNCLASSIFIED.)
155. S. Yajima. "Development of Ceramics, Especially Silicon Carbide Fibers From Organosilicon Polymers by Heat Treatment." *Phil. Trans. R. Soc. Lond.* Vol. A 294 (1980), pp. 419-426.
156. Y. Hasegawa and others. "Synthesis of Continuous Silicon Carbide Fiber. Part 2. Conversion of Polycarbosilane Fiber Into Silicon Carbide Fibers." *J. Mater. Sci.*, Vol. 15, No. 3 (1980), pp. 720-728.

NWC TP 6499

157. S. Yajima and others. "Synthesis of Continuous Silicon Carbide Fiber With High Tensile Strength and High Young's Modulus. Part 1. Synthesis of Polycarbosilane as Precursor." *J. Mater. Sci.*, Vol 13, No. 12 (1978), pp. 2569-2576.
158. S. Yajima. "Development of Heat-Resisting Materials Using Organosilicon Polymers as the Precursor." *New Dev. Appl. Compos.*, Proc. Symp., Warrendale, PA, Metall. Soc. AIME, 1979. pp. 241-251.
159. S. Yajima. "Development of Ceramics, Especially Silicon Carbide Fibers, From Organosilicon Polymers by Heat Treatment." *Philos. Trans. R. Soc. London*, Ser. A, Vol. 294, No. 1411 (1980), pp. 419-426.

NOMENCLATURE

| | |
|------------------------------|--|
| bp | Boiling point |
| C ¹³ | Carbon-13 |
| DMSO | Dimethylsulfoxide |
| DP | Degree of polymerization |
| d ₂₅ | Density at 25°C |
| GPC | Gel permeation chromatography |
| IR | Infrared |
| M _n | Number average molecular weight of a polymer |
| mp | Melting point |
| M _w | Weight average molecular weight of a polymer |
| NMR | Nuclear magnetic resonance |
| n _D | Index of refraction |
| n _D ²⁵ | Index of refraction at 25°C |
| T _g | Glass transition temperature |
| TGA | Thermogravimetric analysis |
| THF | Tetrahydrofuran |
| η | Intrinsic viscosity |
| π | Pi |

INITIAL DISTRIBUTION

14 Naval Air Systems Command

- AIR-03A (1)
- AIR-301B (2)
- AIR-313B (1)
- AIR-32 (1)
- AIR-320 (1)
- AIR-320C (1)
- AIR-330 (1)
- AIR-5363 (1)
- AIR-5422, T. Capello (1)
- AIR-7226 (2)
- ADP-023 (1)
- PMA-268 (1)

5 Chief of Naval Material

- MAT-030 (1)
- MAT-030B (1)
- MAT-032 (1)
- NSP-27 (1)
- NSP-2731 (1)

1 Chief of Naval Research (Code 413, K. Wynne)

6 Naval Sea Systems Command

- SEA-04H (1)
- SEA-09B312 (2)
- SEA-521 (1)
- SEA-62Z2 (2)

1 Commander in Chief, U.S. Pacific Fleet (Code 325)

3 Marine Corps Development and Education Command, Quantico (Marine Corps Landing Force Development Center)

1 Commander, Third Fleet, Pearl Harbor

1 Commander, Seventh Fleet, San Francisco

1 Air Test and Evaluation Squadron 5

1 David W. Taylor Naval Ship Research and Development Center, Bethesda (Code 166, J. F. Talbot)

1 Elect. Analysis Center, Naval Weapons Station, Seal Beach, Corona (Library)

2 Naval Academy, Annapolis, Director of Research

1 Naval Air Development Center, Warminster (Code 606)

1 Naval Explosive Ordnance Disposal Technology Center (Indian Head)

2 Naval Intelligence Support Center

- NISC-60, Library (1)

- LNN, Liaison Officer (1)

1 Naval Ocean Systems Center, San Diego (Code 133)

2 Naval Ordnance Station, Indian Head

- Code 5251A, R. Bazil (1)
- Code TDD, A. T. Camp (1)

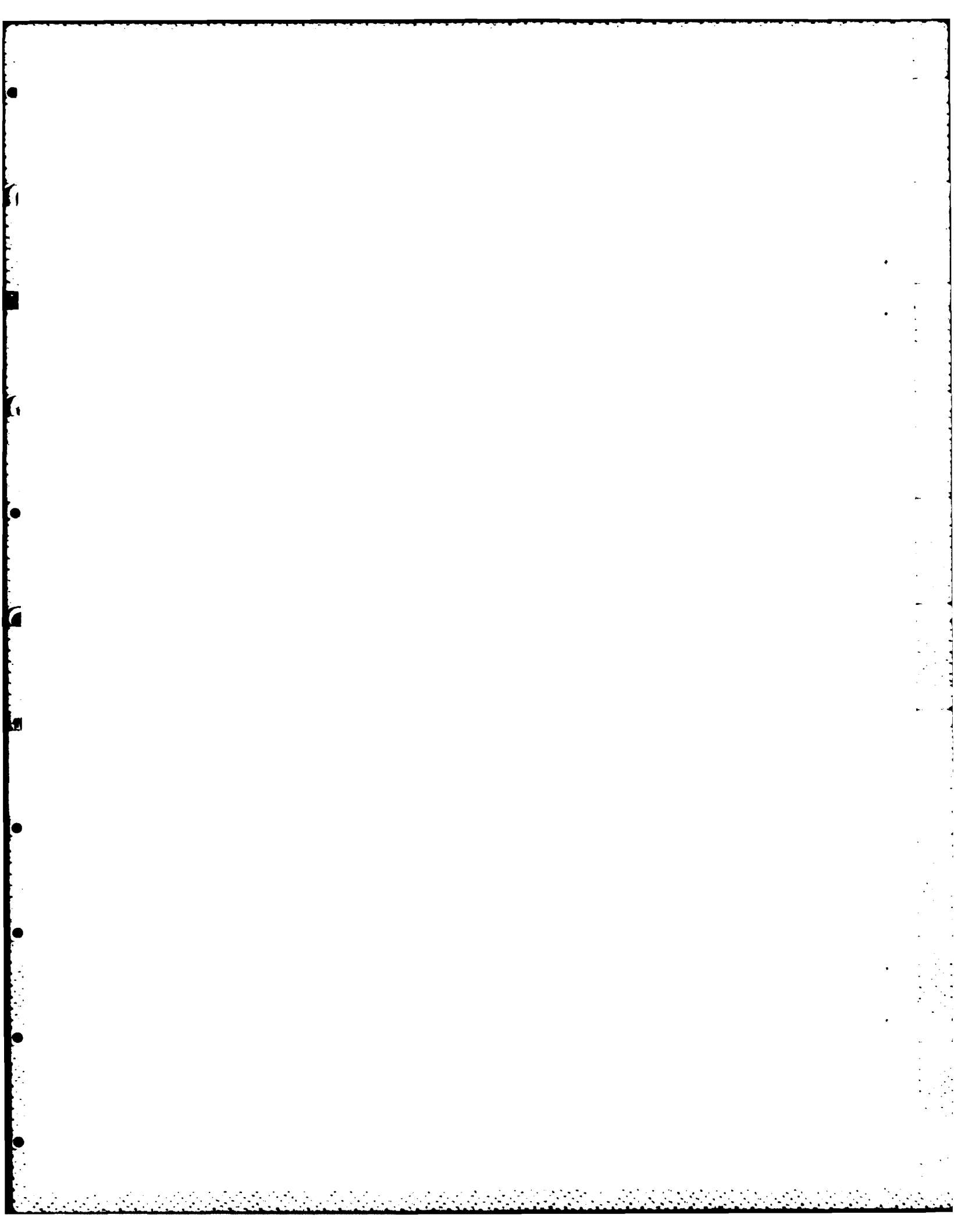
3 Naval Ship Weapon Systems Engineering Station, 1907 Huachuca

- Code 5711, Repository (2)
- Code 5712 (1)

NWC TP 6499

- 3 Naval Surface Weapons Center, Dahlgren
 - Code DG (1)
 - Code DG50 (1)
 - Code G20 (1)
- 2 Naval Surface Weapons Center, Indian Head Detachment, Indian Head
 - R16
 - W. Barber (1)
 - O. Dengel (1)
- 3 Naval Surface Weapons Center, White Oak Laboratory, Silver Spring
 - K24, W. C. Ragsdale (1)
 - R30 (1)
 - R31 (1)
- 1 Naval War College, Newport
- 1 Naval Weapons Support Center, Crane
- 1 Army Armament Materiel Readiness Command, Rock Island (DRSAR-LEM)
- 4 Army Armament Research and Development Command, Dover (DRDAR-LCN-C, Concepts and Analysis Branch)
- 2 Army Missile Command, Redstone Arsenal
 - DRSMI-R, Dr. R. C. Rhoades (1)
 - DRSMI-RKK, G. Brock (1)
- 1 Army Ballistic Research Laboratory, Aberdeen Proving Ground (DRDAR-TSB-S (STINFO))
- 2 Air Force Systems Command, Andrews Air Force Base
 - DLFP (1)
 - SDZ (1)
- 7 Air Force Armament Division, Eglin Air Force Base
 - AFATL/DLD (1)
 - AFATL/DLDE (1)
 - AFATL/DLJW (1)
 - AFATL/DLMA (1)
 - AFATL/DLMI, Aden (1)
 - AFATL/DLO (1)
 - AFATL/DLODL (1)
- 1 Air Force Intelligence Service, Bolling Air Force Base (AFIS/INTAW, Maj. R. Lecklider)
- 1 Air Force Rocket Propulsion Laboratory, Edwards Air Force Base (Code MKAS, L. Sedillo)
- 1 Air Force Rocket Propulsion Laboratory, Edwards Air Force Base (Code MKAT, M. Dawson)
- 1 Air Force Rocket Propulsion Laboratory, Edwards Air Force Base (Code MKCC)
- 1 Air Force Rocket Propulsion Laboratory, Edwards Air Force Base (Code MKP)
- 1 Air Force Rocket Propulsion Laboratory, Edwards Air Force Base (Code TOAB, D. Parker)
- 1 Air Force Rocket Propulsion Laboratory, Edwards Air Force Base (J. Koury)
- 1 Air Force Wright Aeronautical Laboratories, Wright-Patterson Air Force Base (AFWAL/MISE, J. Rhodehamel)
- 1 Air Force Wright Aeronautical Laboratories, Wright-Patterson Air Force Base (AFWAL/MLBT, J. Sieron)
- 1 Air Force Wright Aeronautical Laboratories, Wright-Patterson Air Force Base (AFWAL/PORA, W. Burson)
- 1 Air Force Wright Aeronautical Laboratories, Wright-Patterson Air Force Base (AFWAL/PORT)
- 1 Air Force Wright Aeronautical Laboratories, Wright-Patterson Air Force Base (AFWAL/TST, Technical Library)
- 1 Foreign Technology Division, Wright-Patterson Air Force Base (Code SDNW, J. Woodard)
- 1 Defense Advanced Research Projects Agency, Arlington
- 12 Defense Technical Information Center
 - 1 Department of Defense Explosives Safety Board, Alexandria (6-A-145)
 - 1 Department of Energy, Idaho Falls, ID (W. Thielbahr)
 - 1 Lewis Research Center (NASA), Cleveland, OH
 - 1 Acurex Corporation, Mountain View, CA (B. Laub)
 - 1 Atlantic Research Corporation, Gainesville, VA (K. Yezzi)
 - 1 Beech Aircraft Corporation, Wichita, KS
 - 1 Dow Corning Corporation, Midland, MI (Mail No. 069, K. Michaels)
 - 1 Dow Corning U.S.A., Irvine, CA (J. E. Heitler)
 - 1 General Dynamics Corporation, Convair Division, San Diego, CA
 - 1 General Electric Company, Silicone Products Division, Gaithersburg, MD (T. M. Birdwell)
 - 1 General Electric Company, Waterford, NY (Silicone Products Department, Mail No. 12-11, F. Modic)
 - 1 Grumman Aerospace Corporation, Bethpage, NY (TIC L01-35)

- 1 Hercules, Inc., McGregor, TX (Aerospace Division, B. Corley)
- 1 Honeywell, Inc., Systems & Research Center, Minneapolis, MN
- 1 Hughes Aircraft Company, El Segundo, CA
- 1 Hughes Aircraft Company, Missile Systems Division, Canoga Park, CA
- 1 Martin Marietta Aerospace, Orlando, FL
- 1 McDonnell Douglas Corporation, St. Louis, MO (J. L. Bledsoe, Dept. E241)
- 2 Morton-Thiokol Corporation, Huntsville Division, Huntsville, AL
 - J. Byrd (1)
 - J. Hightower (1)
- 1 Rockwell International Corporation, Columbus, OH (R. C. Wykes)
- 1 Teledyne-Ryan Aeronautical, San Diego, CA
- 1 The Boeing Company, Seattle, WA
- 2 The Johns Hopkins University, Applied Physics Laboratory, Laurel, MD
 - W. B. Shippen (1)
 - L. B. Weckesser (1)
- 1 The Marquardt Company, Van Nuys, CA
- 1 Union Carbide Corporation, Tarrytown, NY (C. L. Schilling)
- 2 United Technologies Corporation, Chemical Systems Division, Sunnyvale, CA
 - R. Kromrey (1)
 - T. D. Meyers (1)
- 1 United Technologies Research Center, East Hartford, CT (Document Control Station (R. L. O'Brien))
- 93 Chemical Propulsion Mailing List dated December 1982, including categories 1, 2, 3, 4, 5



END

FILMED

5-85

DTIC